

32Mb (2M x 16 bit) U t RAM

INFORMATION IN THIS DOCUMENT IS PROVIDED IN RELATION TO SAMSUNG PRODUCTS, AND IS SUBJECT TO CHANGE WITHOUT NOTICE.

NOTHING IN THIS DOCUMENT SHALL BE CONSTRUED AS GRANTING ANY LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IN SAMSUNG PRODUCTS OR TECHNOLOGY.

ALL INFORMATION IN THIS DOCUMENT IS PROVIDED ON AS "AS IS" BASIS WITHOUT GUARANTEE OR WARRANTY OF ANY KIND.

1. For updates or additional information about Samsung products, contact your nearest Samsung office.
2. Samsung products are not intended for use in life support, critical care, medical, safety equipment, or similar applications where Product failure could result in loss of life or personal or physical harm, or any military or defense application, or any governmental procurement to which special terms or provisions may apply.

* Samsung Electronics reserves the right to change products or specification without notice.

Document Title

2Mx16 bit Multiplexed Synchronous Burst Uni-Transistor Random Access Memory

Revision History

| <u>Revision No.</u> | <u>History</u> | <u>Draft Date</u> | <u>Remark</u> |
|---------------------|---|-------------------|---------------|
| 0.0 | Initial - Design target | December 19, 2006 | Preliminary |
| 0.1 | Revised - Inserted package dimension | January 11, 2007 | Preliminary |

K1B3216B8E

Table of Contents

| | |
|--|----|
| GENERAL DESCRIPTION..... | 1 |
| FEATURES | 1 |
| PRODUCT FAMILY | 1 |
| PIN DESCRIPTIONS & FUNCTION BLOCK DIAGRAM..... | 2 |
| TERMINOLOGY DESCRIPTION | 2 |
| POWER UP SEQUENCE..... | 3 |
| MODE STATE MACHINE..... | 3 |
| ABSOLUTE MAXIMUM RATINGS | 4 |
| RECOMMENDED DC OPERATING CONDITIONS..... | 4 |
| CAPACITANCE..... | 4 |
| DC AND OPERATING CHARACTERISTICS..... | 4 |
| MRS (MODE REGISTER SET) | 5 |
| MRS CODE | 5 |
| MRS TIMING WAVEFORM (SOFTWARE) | 6 |
| PAR (Partial Array Refresh) mode A/DQ[3]~A/DQ[0] | 7 |
| DPD (Deep Power Down) mode A/DQ[4] | 7 |
| Burst Length A/DQ[7]~A/DQ[5] & Wrap A/DQ[12] | 8 |
| WAIT Configuration A/DQ[8] & WAIT Polarity A/DQ[13] | 8 |
| Latency A/DQ[11]~A/DQ[9]..... | 9 |
| Driver Strength A/DQ[17]~A/DQ[16]..... | 9 |
| OPERATION MODE (A/DQ[15]~A/DQ[14])..... | 10 |
| MODE1. ASYNCHRONOUS READ / ASYNCHRONOUS WRITE MODE | 10 |
| MODE2. SYNCHRONOUS BURST READ / ASYNCHRONOUS WRITE MODE | 11 |
| MODE3. SYNCHRONOUS BURST READ / SYNCHRONOUS BURST WRITE MODE | 12 |
| MODE 1 AC OPERATING CONDITIONS (ASYNCH. READ / ASYNCH. WRITE)..... | 13 |
| TIMING WAVEFORMS (ASYNCH. READ / ASYNCH. WRITE)..... | 14 |
| Asynch. READ | 14 |
| Asynchronous WRITE | 15 |
| MODE 2 AC OPERATING CONDITIONS (SYNCH. READ / ASYNCH. WRITE) | 16 |
| TIMING WAVEFORMS (SYNCH. READ / SYNCH. WRITE) | 17 |
| Burst READ - Fixed Latency..... | 17 |
| Burst READ - Variable Latency | 18 |
| Burst READ STOP..... | 19 |
| Asynch. WRITE | 20 |
| Burst READ followed by Asynch. WRITE | 21 |
| Asynch. WRITE followed by Burst READ | 22 |
| MODE3. AC OPERATING CONDITIONS (SYNCH. READ / SYNCH. WRITE)..... | 23 |
| TIMING WAVEFORMS (SYNCH. READ / SYNCH. WRITE) | 24 |
| Burst READ - Fixed Latency..... | 24 |
| Burst READ - Variable Latency | 25 |
| Burst READ STOP..... | 26 |
| Burst WRITE..... | 27 |
| Burst WRITE (ADV PULSE Interrupt)..... | 28 |
| Burst READ STOP & Burst WRITE STOP | 29 |
| Burst READ followed by Burst WRITE | 30 |
| Burst WRITE followed by Burst READ | 31 |
| PACKAGE DIMENSION..... | 32 |
| 54 BALL FINE PITCH BGA(0.75mm ball pitch)..... | 32 |

K1B3216B8E

2M x 16 bit Multiplexed Synchronous Burst Uni-Transistor CMOS RAM

GENERAL DESCRIPTION

The world is moving into the mobile multi-media era and therefore the mobile handsets need bigger & faster memory capacity to handle the multi-media data. SAMSUNG's UtRAM products are designed to meet all the request from the various customers who want to cope with the fast growing mobile market. UtRAM is the perfect solution for the mobile market with its low cost, high density and high performance feature. K1B3216B8E is fabricated by SAMSUNG's advanced CMOS technology using one transistor memory cell. The device supports the traditional SRAM like asynchronous operation (asynchronous page read and asynchronous write), the NOR flash like synchronous operation (synchronous burst read and asynchronous write) and the fully synchronous operation (synchronous burst read and synchronous burst write). These three operation modes are defined through the mode register setting. The device also supports the special features for the standby power saving. Those are the Partial Array Refresh(PAR) mode, Deep Power Down(DPD) mode and internal TCSR (Temperature Compensated Self Refresh). The optimization of output drive strength is possible through the mode register setting to adjust for the different data loadings. Through this drive strength optimization, the device can minimize the noise generated on the data bus during read operation.

FEATURES

- Process technology: CMOS
- Organization: 2M x 16 bit
- Multiplexed Address and Data bus
- Power supply voltage: 1.7V~1.95V
- Three state outputs
- Supports MRS (Mode Register Set)
 - Software set up
- Supports power saving modes
 - PAR (Partial Array Refresh)
 - DPD (Deep Power Down)
 - Internal TCSR (Temperature Compensated Self Refresh)
- Supports driver strength optimization
- K1B3216B8E supports
 - Asynchronous read/ Asynchronous write
 - Synchronous burst read / Asynchronous write
 - Synchronous burst read / Synchronous burst write
- Synchronous burst operation
 - Max. clock frequency : 104MHz
 - Fixed and Variable read latency
 - 4 / 8 / 16 / 32 and Continuous burst
 - Wrap / No-wrap
 - Latency :4(Variable) @ 104MHz
3(Variable) @ 80MHz
2(Variable) @ 66MHz
 - Burst stop
 - Burst read suspend
 - Burst write data masking

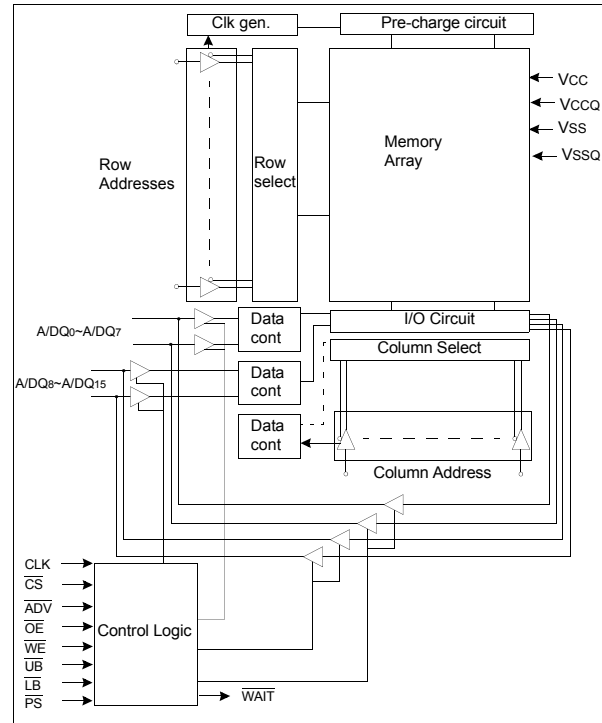
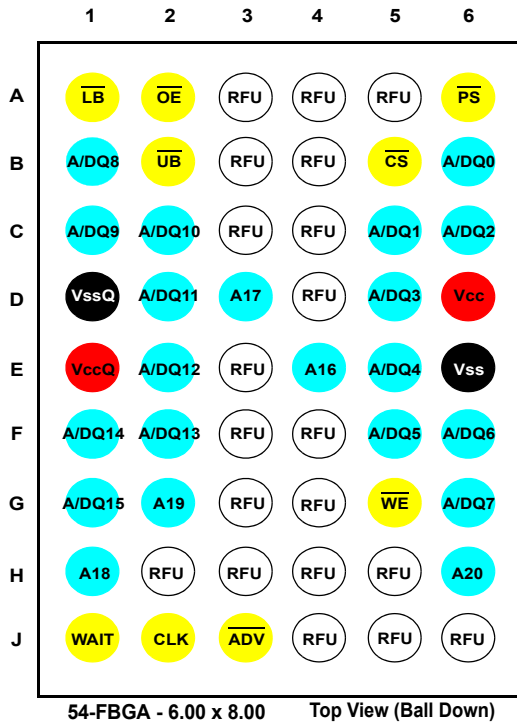
PRODUCT FAMILY

| Product Family | Operating Mode ¹⁾ | Operating Temp. | Vcc Range | Speed | Current Consumption | |
|----------------|------------------------------|----------------------|-----------|--------|-----------------------------------|-------------------------------------|
| | | | | | Standby (I _{sb1} , Max.) | Operating (I _{cc2} , Max.) |
| K1B3216B8E-I | Mode 1 Mode 2 Mode 3 | Industrial(-40~85°C) | 1.7~1.95V | 104MHz | TBD < 85°C TBD < 40°C | TBD |

- 1) Mode 1: Asynchronous read/ Asynchronous write
 Mode 2: Synchronous burst read/ Asynchronous write
 Mode 3: Synchronous burst read/ Synchronous burst write

K1B3216B8E

PIN DESCRIPTIONS & FUNCTION BLOCK DIAGRAM



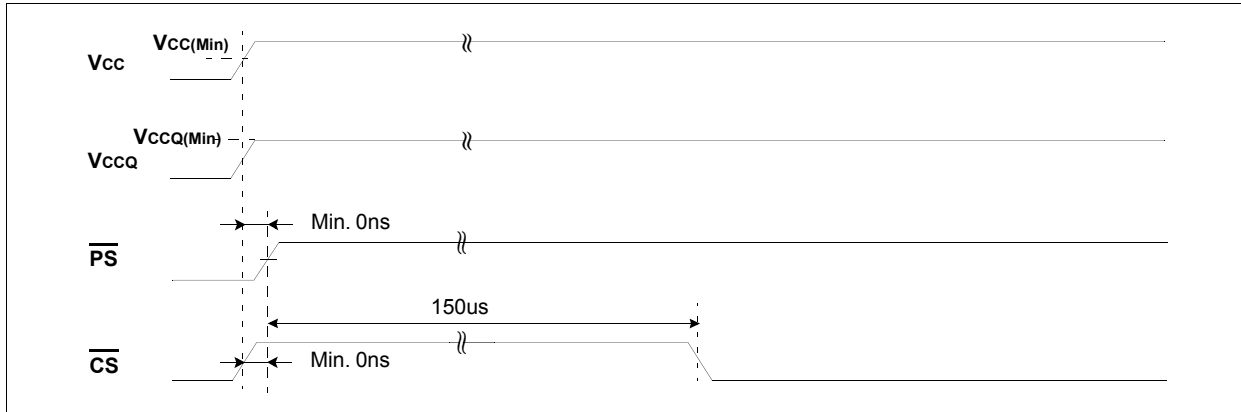
TERMINOLOGY DESCRIPTION

| Name | Function | Type | Description |
|--------------|-----------------------------------|--------------|--|
| CLK | Clock | Input | Synchronizes the memory to the system operating frequency during synchronous operations. Commands are referenced to CLK. |
| ADV | Address Valid | Input | Indicates that a valid address is present on the address inputs. Addresses can be latched on the rising edge of ADV during asynchronous READ and WRITE operations. |
| PS | Mode Register set | Input | \overline{PS} low enables either PAR or DPD to be set. |
| CS | Chip Select | Input | \overline{CS} low enables the chip to be active \overline{CS} high disables the chip and puts it into standby mode or deep power down mode. |
| OE | Output Enable | Input | Enables the output buffers when LOW. when \overline{OE} is HIGH, the output buffers are disabled. |
| WE | Write Enable | Input | \overline{WE} low enables the chip to start writing the data |
| LB | Lower Byte (I/O _{0~7}) | Input | \overline{UB} (\overline{LB}) low enables upper byte (lower byte) to allow data Input/output from I/O buffers. |
| UB | Upper Byte (I/O _{8~15}) | Input | |
| A16~A20 | Address 16 ~ Address 20 | Input | Inputs for addresses during READ and WRITE operations. Addresses are internally latched during READ and WRITE cycles. |
| A/DQ0~A/DQ15 | Address and Data Inputs / Outputs | Input/Output | Address and Data I/Os: These pins are multiplexed address/ data bus. |
| Vcc | Voltage Source | Power | Device Power supply. Power supply for device core operation. |
| VccQ | I/O Voltage Source | Power | I/O Power supply. Power supply for input/output buffers. |
| Vss | Ground Source | GND | Ground for device core operation |
| VssQ | I/O Ground Source | GND | Ground for input/output buffers |
| WAIT | Valid Data Indicator | Output | The WAIT signal is output signal indicating the status of the data on the bus whether or not it is valid. WAIT is asserted when a burst crosses a word-line boundary. WAIT is asserted and should be ignored during asynchronous and page mode operations. |

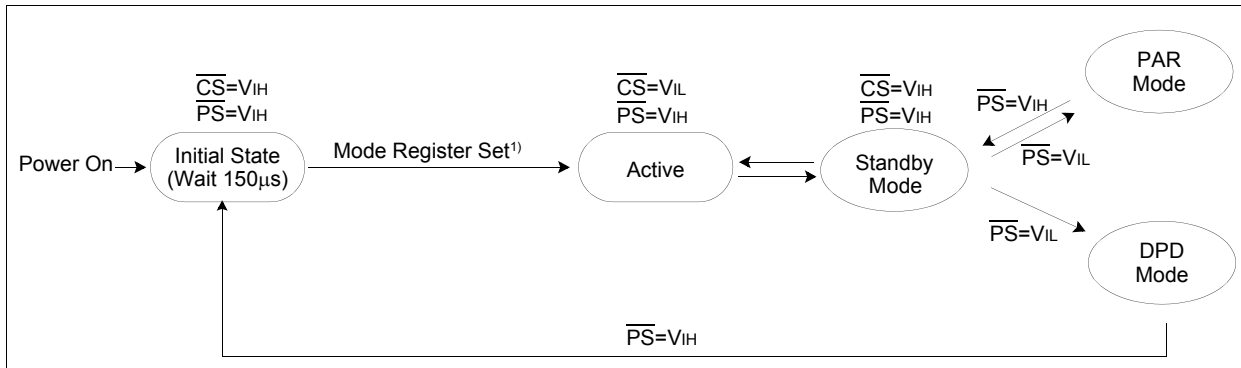
K1B3216B8E

POWER UP SEQUENCE

After V_{CC} and V_{CCQ} reach minimum operating voltage(1.7V), drive \overline{CS} High first and then drive \overline{PS} High. Then the device gets into the Power Up mode. Wait for minimum 150 μ s to get into the normal operation mode. During the Power Up mode, the standby current can not be guaranteed. To get the stable standby current level, at least one cycle of active operation should be implemented regardless of wait time duration. To get the appropriate device operation, be sure to keep the following power up sequence. Mode1 (Asynchronous read/ Asynchronous write) is set up after power up, but this mode is not always guaranteed.



MODE STATE MACHINE



1) Refer to MRS(Mode Register Set).

ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Ratings | Unit |
|--------------------------------------|------------------------------------|--------------------------------|------|
| Voltage on any pin relative to Vss | V _{IN} , V _{OUT} | -0.2 to V _{CCQ} +0.3V | V |
| Power supply voltage relative to Vss | V _{CC} , V _{CCQ} | -0.2 to 2.5V | V |
| Power Dissipation | P _D | 1.0 | W |
| Storage temperature | T _{STG} | -65 to 150 | °C |
| Operating Temperature | T _A | -40 to 85 | °C |

1) Stresses greater than "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation should be restricted to be used under recommended operating condition. Exposure to absolute maximum rating conditions longer than 1 second may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS

| Item | Symbol | Min | Typ | Max | Unit |
|----------------------------|------------------------------------|-----------------------|-----|-------------------------------------|------|
| Power supply voltage(Core) | V _{CC} | 1.7 | 1.8 | 1.95 | V |
| Power supply voltage(I/O) | V _{CCQ} | 1.7 | 1.8 | 1.95 | V |
| Ground | V _{SS} , V _{SSQ} | 0 | 0 | 0 | V |
| Input high voltage | V _{IH} | V _{CCQ} -0.4 | - | V _{CCQ} +0.2 ²⁾ | V |
| Input low voltage | V _{IL} | -0.2 ³⁾ | - | 0.4 | V |

1. T_A=-40 to 85°C, otherwise specified.

2. Overshoot: V_{CCQ}+1.0V in case of pulse width ≤20ns. Overshoot is sampled, not 100% tested.

3. Undershoot: -1.0V in case of pulse width ≤20ns. Undershoot is sampled, not 100% tested.

CAPACITANCE (f=1MHz, T_A=25°C)

| Item | Symbol | Test Condition | Min | Max | Unit |
|--------------------------|-----------------|---------------------|-----|-----|------|
| Input capacitance | C _{IN} | V _{IN} =0V | - | 8 | pF |
| Input/Output capacitance | C _{IO} | V _{IO} =0V | - | 8 | pF |

DC AND OPERATING CHARACTERISTICS

| Item | Symbol | Test Conditions | Min | Typ | Max | Unit | | |
|----------------------------------|--------------------------------|--|--------|-----------|-----|------|-----|----|
| Input Leakage Current | I _{LI} | V _{IN} =V _{SS} to V _{CCQ} | -1 | - | 1 | μA | | |
| Output Leakage Current | I _{LO} | $\overline{CS}=V_{IH}$, $\overline{PS}=V_{IH}$, $\overline{OE}=V_{IH}$ or $\overline{WE}=V_{IL}$, V _{IO} =V _{SS} to V _{CCQ} | -1 | - | 1 | μA | | |
| Average Operating Current(Async) | I _{CC2} ⁶⁾ | Cycle time=70ns, I _{IO} =0mA ⁴⁾ , 100% duty, $\overline{CS}=V_{IL}$, $\overline{PS}=V_{IH}$, V _{IN} =V _{IL} or V _{IH} | - | - | TBD | mA | | |
| Average Operating Current(Sync) | I _{CC3} | Burst Length 4, Latency 5, 104MHz, I _{IO} =0mA ⁴⁾ , Address transition 1 time, $\overline{CS}=V_{IL}$, $\overline{PS}=V_{IH}$, V _{IN} =V _{IL} or V _{IH} | - | - | TBD | mA | | |
| Output Low Voltage | V _{OL} | I _{OL} =0.2mA | - | - | 0.2 | V | | |
| Output High Voltage | V _{OH} | I _{OH} =-0.2mA | 1.4 | - | - | V | | |
| Standby Current(CMOS) | I _{SB1} ¹⁾ | $\overline{CS} \geq V_{CCQ}-0.2V$, $\overline{PS} \geq V_{CCQ}-0.2V$, Other inputs=V _{SS} or V _{CCQ} (Toggle is not allowed) ⁵⁾ | < 40°C | - | - | TBD | μA | |
| | | | < 85°C | - | - | TBD | μA | |
| Partial Refresh Current | I _{SBP} ²⁾ | $\overline{PS} \leq 0.2V$, $\overline{CS} \geq V_{CCQ}-0.2V$, Other inputs=V _{SS} or V _{CCQ} (Toggle is not allowed) ⁵⁾ | < 40°C | 1/2 Block | - | - | TBD | μA |
| | | | | 1/4 Block | - | - | TBD | |
| | | | < 85°C | 1/2 Block | - | - | TBD | μA |
| | | | | 1/4 Block | - | - | TBD | |
| Deep Power Down Current | I _{SD} | $\overline{PS} \leq 0.2V$, $\overline{CS} \geq V_{CCQ}-0.2V$, Other inputs=V _{SS} or V _{CCQ} (Toggle is not allowed) ⁵⁾ | < 85°C | - | - | TBD | μA | |

1. I_{SB1} is measured after 60ms after \overline{CS} high. CLK should be fixed at high or at Low.

2. Full Array Partial Refresh Current(I_{SBP}) is same as Standby Current(I_{SB1}).

3. Internal TCSR (Temperature Compensated Self Refresh) is used to optimize refresh cycle below 40°C.

4. I_{IO}=0mA; This parameter is specified with the outputs disabled to avoid external loading effects.

5. V_{IN}=0V; all inputs should not be toggle.

6. Clock should not be inserted between ADV low and \overline{WE} low during Write operation.

MRS (MODE REGISTER SET)

The mode registers store the values for the various modes to make U_tRAM suitable for a various applications through MRS. The mode registers have lots of fields and each field consists of several options. Refer to the Table below for detailed Mode Register Setting. A19~A20 addresses are "Don't care" in Mode Register Setting.

MRS CODE

MRS code consists of 12 categories and several options in each category. RARS, PARA, PAR and DPD are related to power saving, BL, WC, Latency, Wrap, WP, MS and IL are related to bus operation and DS is related to device output impedance.

Mode Register Setting according to field of function

| Address | A18 | A17~A16 | A/DQ15~A/DQ14 | A/DQ13 | A/DQ12 | A/DQ11~A/DQ9 | A/DQ8 | A/DQ7~A/DQ5 | A/DQ4 | A/DQ3 | A/DQ2 | A/DQ1~A/DQ0 |
|----------|-----|---------|---------------|--------|--------|--------------|-------|-------------|-------|-------|-------|-------------|
| Function | IL | DS | MS | WP | Wrap | Latency | WC | BL | DPD | PAR | PARA | PARS |

| Initial Latency | | Driver Strength | | | | Mode Select | | | | |
|-----------------|----------|-----------------|-----|------------|--------|-------------|---|--|--|--|
| A18 | IL | A17 | A16 | DS | A/DQ15 | A/DQ14 | MS | | | |
| 0 | Fixed | 0 | 0 | Full Drive | 0 | 0 | Mode 1 (Async. Read / Async. Write) | | | |
| 1 | Variable | 0 | 1 | 1/2 Drive | 0 | 1 | Mode 2 (Sync. Burst Read / Async. Write) | | | |
| | | 1 | 0 | 1/4 Drive | 1 | 0 | Mode 3 (Sync. Burst Read / Sync. Burst Write) | | | |

| WAIT Polarity | | Wrap | | Latency Count | | | | Wait Configuration | | Burst Length | | | |
|---------------|------------------|--------|---------|---------------|--------|-------|---------|--------------------|-----------------|--------------|-------|-------|--------------------------|
| A/DQ13 | WP ¹⁾ | A/DQ12 | Wrap | A/DQ11 | A/DQ10 | A/DQ9 | Latency | A/DQ8 | WC | A/DQ7 | A/DQ6 | A/DQ5 | BL |
| 0 | Low Enable | 0 | Wrap | 1 | 0 | 0 | 2 | 0 | One clock prior | 0 | 1 | 0 | 4 word |
| 1 | High Enable | 1 | No-Wrap | 0 | 0 | 0 | 3 | 1 | At data | 0 | 1 | 1 | 8 word |
| | | | | 0 | 0 | 1 | 4 | | | 1 | 0 | 0 | 16 word |
| | | | | 0 | 1 | 0 | 5 | | | 1 | 0 | 1 | 32 word |
| | | | | 0 | 1 | 1 | 6 | | | 1 | 1 | 1 | Continuous ²⁾ |
| | | | | 1 | 0 | 1 | 7 | | | | | | |
| | | | | 1 | 1 | 0 | 8 | | | | | | |
| | | | 9 | | | | | | | | | | |

| Deep Power Down | | Partial Array Refresh | | PAR Array | | PAR Size | | |
|-----------------|-------------|-----------------------|-------------|-----------|--------------|----------|-------|------------|
| A/DQ4 | DPD | A/DQ3 | PAR | A/DQ2 | PARA | A/DQ1 | A/DQ0 | PARS |
| 0 | DPD Enable | 0 | PAR Enable | 0 | Bottom Array | 0 | 0 | Full Array |
| 1 | DPD Disable | 1 | PAR Disable | 1 | Top Array | 1 | 0 | 1/2 Array |
| | | | | | | 1 | 1 | 1/4 Array |

[Note]

- A19~A20 addresses are "Don't care" & reserved for future use.

- The modes are set automatically to default modes which are Async. Read and Async. Write/ DPD disable / PAR disable after power up or DPD exit.

- Mode Change Rules.

Mode1(2) to Mode3 : 1 dummy write(to any address with any data) is necessary before setting Mode3

* Dummy write: Dummy write timing is just the same with normal write timing. It is necessary because 'Late write' is applied to Asynchronous write as in Mode1(2).

* Late write: The data that is latched in previous write cycle is written in the address that is also latched in previous write cycle when Write starts. And current data and address are latched when Write ends. (WE high or CS high, whichever comes first)

Mode3 to Mode1(2) : 1 dummy write is necessary before setting Mode1(2)

* Dummy write: The data and the address should be the same with those which are used during Mode1(2) to Mode3 transition.

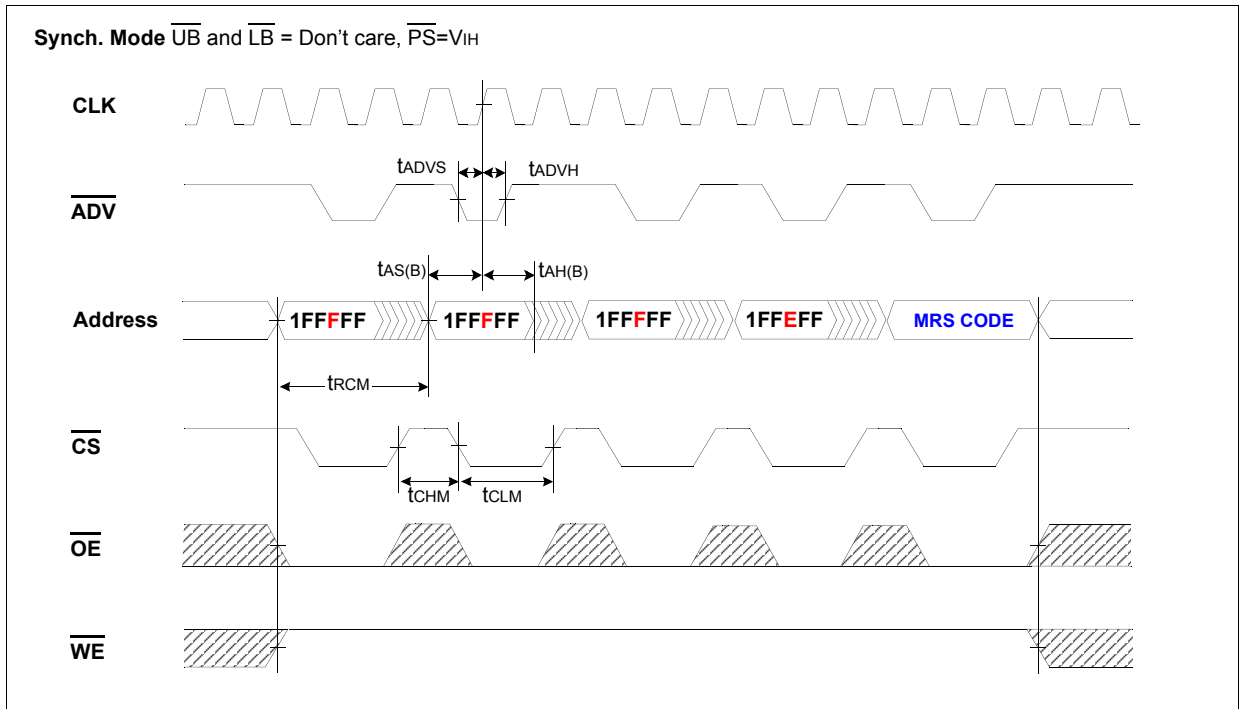
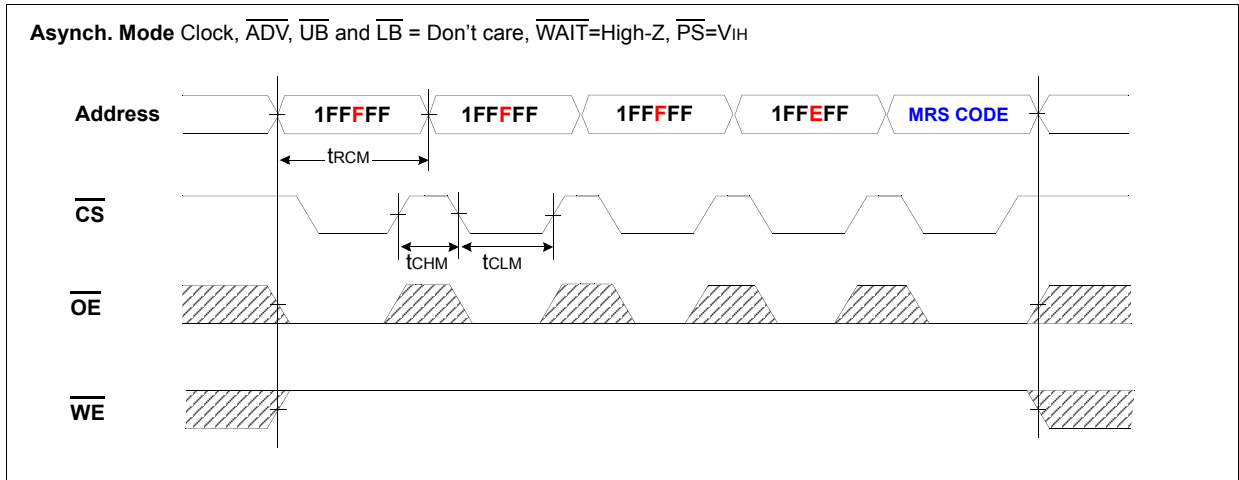
1) WP[0]: The data is available when $\overline{\text{WAIT}}$ signal is High. All the timings in this spec are illustrated based on this mode.

WP[1]: The data is available when WAIT signal is Low.

2) Refresh command will be denied during continuous operation. $\overline{\text{CS}}$ low should not be longer than tBC(max. 2.5us)

MRS TIMING WAVEFORM (SOFTWARE)

Software MRS timing consists of 5 Read cycles. Each cycle is normal Read cycle. \overline{CS} pin should be toggling between cycles. 1st, 2nd and 3rd cycle should be 1FFFFF(h), 4th cycle should be 1FFEFF(h) and 5th cycle should be MRS code



Note) Above timing and address condition should not be used in the normal operation. The above condition should be used only for the mode register setting purpose.

AC CHARACTERISTICS

| Parameter List | Symbol | Min | Max | Units | Parameter List | Symbol | Min | Max | Units |
|---------------------------------------|--------|-----|-----|-------|---------------------------|--------|-----|-----|-------|
| \overline{ADV} setup time to clock | tADVS | 3 | - | ns | Read cycle time | tRCM | 70 | - | ns |
| \overline{ADV} hold time from clock | tADVH | 2 | - | ns | \overline{CS} high time | tCHM | 10 | - | ns |
| Address setup time to clock | tAS(B) | 3 | - | ns | \overline{CS} low time | tCLM | 60 | - | ns |
| Address hold time from clock | tAH(B) | 2 | - | ns | | | | | |

K1B3216B8E

PAR (Partial Array Refresh) mode A/DQ[3]~A/DQ[0]

User can select half array, a fourth array as active memory array. The active memory array is periodically refreshed(data stored), whereas the disabled array is not going to be refreshed and so the previously stored data will be invalid. When re-enabling additional portions of the array, the new portions are available immediately upon writing to the MRS.

PAR mode execution;

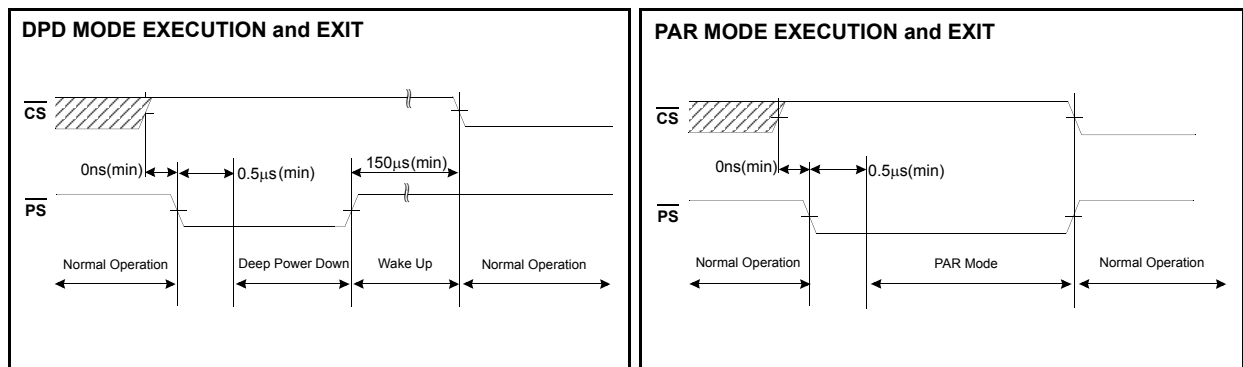
- 1) Mode Register Setting into PAR enable(A/DQ3=0)
DPD enabled setting(A/DQ4=0) has higher priority to PAR enabled setting(A/DQ3=0). A/DQ4=1 is necessary to use PAR mode.
 - 2) PAR mode Enter; keep \overline{PS} signal at V_{IL} for longer than 0.5 μ s during standby mode (Mode Register: A/DQ4=1 & A/DQ3=0).
 - 3) PAR mode Exit; The device returns to the standby mode when \overline{PS} signal goes to V_{IH} during PAR mode.
- * Mode register values are not changed after the device has been to PAR mode.

DPD (Deep Power Down) mode A/DQ[4]

The deep power down mode disables all the refresh related activities. This mode can be used when the system needs to save power. The data become invalid when DPD mode is executed.

DPD mode execution ;

- 1) Mode Register Setting into DPD enable(A/DQ4=0)
 - 2) DPD mode Enter; keep \overline{PS} signal at V_{IL} for more than 0.5 μ s during standby mode (Mode Register: A/DQ4=0).
 - 3) DPD mode Exit; The device returns to initial State when \overline{PS} signal goes to V_{IH} during DPD mode. Wake up sequence is needed for the device to do normal operation.
- * Mode register values are initialized to default value after the device has been to DPD mode.
Default modes are Async. Read and Async. Write / DPD disable / PAR disable.



STANDBY MODE CHARACTERISTICS

| Power Mode | Address (Bottom Array) ²⁾ | Address (Top Array) ²⁾ | Memory Cell Data | Standby ³⁾ (ISB1, <40°C) | Standby ³⁾ (ISB1, <85°C) | Wait Time(µs) |
|----------------------------|--------------------------------------|-----------------------------------|---------------------|-------------------------------------|-------------------------------------|---------------|
| Standby(Full Array) | 000000h ~ 1FFFFFFh | 000000h ~ 1FFFFFFh | Valid ¹⁾ | TBD | TBD | 0 |
| Partial Refresh(1/2 Block) | 000000h ~ 0FFFFFFh | 100000h ~ 1FFFFFFh | Valid ¹⁾ | TBD | TBD | 0 |
| Partial Refresh(1/4 Block) | 000000h ~ 07FFFFFFh | 180000h ~ 1FFFFFFh | Valid ¹⁾ | TBD | TBD | 0 |
| Deep Power Down | 000000h ~ 1FFFFFFh | | Invalid | TBD | TBD | 150 |

1. Only the data in the selected blocks are valid
2. PAR Array can be selected through Mode Register Set
3. Standby mode is supposed to be set up after at least one active operation after power up.
ISB1 is measured after 60ms from the time when standby mode is set up.

K1B3216B8E

Burst Length A/DQ[7]~A/DQ[5] & Wrap A/DQ[12]

The device supports 4 word, 8 word, 16 word, 32 word and Continuous burst read or write. and Wrap & No-Wrap are supported for Burst sequence.

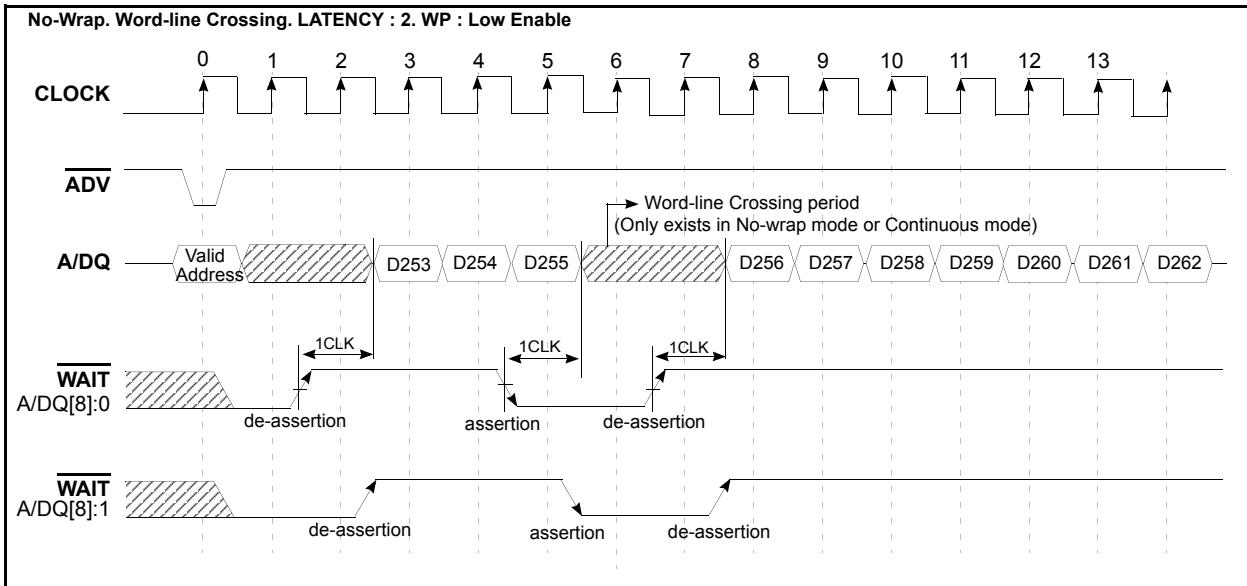
| Burst Address Sequence(Decimal) | | | | | |
|---------------------------------|-------|---------|------------------------|---|--|
| Mode | Start | 4 word | 8 word | 16 word | 32 word |
| WRAP | 0 | 0-1-2-3 | 0-1-2-3-4-5-6-7 | 0-1-2-3-4-5-6-7-8-9-10-11-12-13-14-15 | 0 - 1 - 2 - 3 - 4 - 5 ~ 26-27-28-29-30-31 |
| | 1 | 1-2-3-0 | 1-2-3-4-5-6-7-0 | 1-2-3-4-5-6-7-8-9-10-11-12-13-14-15-0 | 1 - 2 - 3 - 4 - 5 - 6 ~ 27-28-29-30-31 - 0 |
| | 2 | 2-3-0-1 | 2-3-4-5-6-7-0-1 | 2-3-4-5-6-7-8-9-10-11-12-13-14-15-0-1 | 2 - 3 - 4 - 5 - 6 - 7 ~ 28-29-30-31 - 0 - 1 |
| | 3 | 3-0-1-2 | 3-4-5-6-7-0-1-2 | 3-4-5-6-7-8-9-10-11-12-13-14-15-0-1-2 | 3 - 4 - 5 - 6 - 7 - 8 ~ 29-30-31- 0 - 1 - 2 |
| | ~ | | ~ | ~ | ~ |
| | 7 | | 7-0-1-2-3-4-5-6 | 7-8-9-10-11-12-13-14-15-0-1-2-3-4-5-6 | 7 - 8 - 9 - 10 - 11 - 12 ~ 2 - 3 - 4 - 5 - 6 |
| | ~ | | ~ | ~ | ~ |
| | 15 | | | 15-0-1-2-3-4-5-6-7-8-9-10-11-12-13-14 | 15-16-17-18-19-20 ~ 10- 11- 12- 13- 14 |
| ~ | | | | ~ | |
| 31 | | | | 31- 0 - 1 - 2 - 3 - 4 ~ 25-26-27-28-29-30 | |
| No-WRAP | 0 | 0-1-2-3 | 0- 1- 2- 3- 4- 5- 6- 7 | 0- 1- 2- 3- 4- 5- 6- 7- 8- 9- 10- 11- 12-13-14-15 | 0 - 1 - 2 - 3 - 4 - 5 ~ 26-27-28-29-30-31 |
| | 1 | 1-2-3-4 | 1- 2- 3- 4- 5- 6- 7- 8 | 1- 2- 3- 4- 5- 6- 7- 8- 9- 10- 11- 12-13-14-15-16 | 1 - 2 - 3 - 4 - 5 - 6 ~ 27-28-29-30-31-32 |
| | 2 | 2-3-4-5 | 2- 3- 4- 5- 6- 7- 8- 9 | 2- 3- 4- 5- 6- 7- 8- 9- 10- 11- 12-13-14-15-16-17 | 2 - 3 - 4 - 5 - 6 - 7 ~ 28-29-30-31-32-33 |
| | 3 | 3-4-5-6 | 3- 4- 5- 6- 7- 8- 9-10 | 3- 4- 5- 6- 7- 8- 9- 10- 11- 12-13-14-15-16-17-18 | 3 - 4 - 5 - 6 - 7 - 8 ~ 29-30-31-32-33-34 |
| | ~ | | ~ | ~ | ~ |
| | 7 | | 7-8-9-10-11-12-13-14 | 7-8-9-10-11-12-13-14-15-16-17-18-19-20-21-22 | 7 - 8 - 9 - 10-11-12 ~ 33-34-35-36-37-38 |
| | ~ | | ~ | ~ | ~ |
| | 15 | | | 15-16-17-18-19-20-21-22-23-24-25-26-27-28-29-30 | 15-16-17-18-19-20 ~ 41-42-43-44-45-46 |
| ~ | | | | ~ | |
| 31 | | | | 31-32-33-34-35-36 ~ 57-58-59-60-61-62 | |

1. Continuous Burst mode needs to meet tBC(max. 2.5us) parameter.

WAIT Configuration A/DQ[8] & WAIT Polarity A/DQ[13]

The WAIT signal is output signal indicating the status of the data on the bus whether or not it is valid. WAIT configuration is to decide the timing when WAIT asserts or desserts. WAIT asserts (or desserts) one clock prior to the data when A/DQ8 is set to 0. (WAIT asserts (or desserts) at data clock when A/DQ8 is set to 1). WAIT polarity is to decide the WAIT signal level at which data is valid or invalid. Data is valid if WAIT signal is high when A/DQ13 is set to 0. (Data is valid if WAIT signal is low when A/DQ13 is set to 1). All the timing diagrams in this SPEC are illustrated based on following setup; A/DQ[13]:0 and A/DQ[8]:0.

Below timing shows WAIT signal's movement when word boundary crossing happens in No-wrap mode.

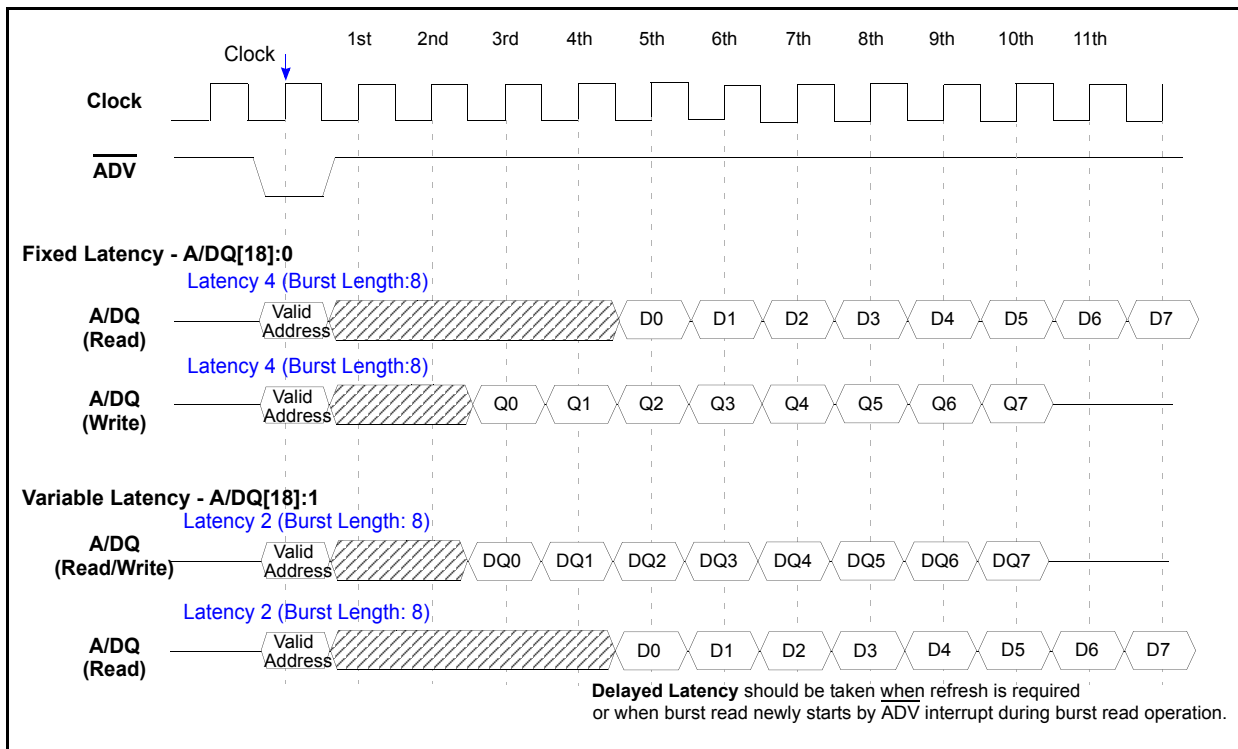


Latency A/DQ[11]~A/DQ[9]

The Latency stands for the number of clocks before the first data available from the burst command.

| Item | Upto 66MHz | | Upto 80MHz | | Upto 104MHz | |
|----------------------------------|------------|-------------------------|------------|-------------------------|-------------|-------------------------|
| | Fixed | Variable | Fixed | Variable | Fixed | Variable |
| Latency Set(A/DQ11:A/DQ10:A/DQ9) | 4(0:0:1) | 2(1:0:0) | 5(0:1:0) | 3(0:0:0) | 7(1:0:1) | 4(0:0:1) |
| Read Latency(min) | 4 | 2 / 4 ¹⁾ | 5 | 3 / 5 ¹⁾ | 7 | 4 / 7 ¹⁾ |
| 1st Read data fetch clock | 5th | 3rd / 5th ¹⁾ | 6th | 4th / 6th ¹⁾ | 8th | 5th / 8th ¹⁾ |
| Write Latency(min) | 2 | 2 | 3 | 3 | 4 | 4 |
| 1st Write data loading clock | 3rd | 3rd | 4th | 4th | 5th | 5th |

1) Delayed Latency should be taken when refresh is required or when burst read newly starts by ADV interrupt during burst read operation.



Driver Strength A/DQ[17]~A/DQ[16]

The optimization of output driver strength is possible to adjust for the different data loadings. The device can minimize the noise generated on the data bus during read operation. The device supports full, 1/2 and 1/4 driver strength. The device's default mode is 1/2 driver strength.

| | | | |
|-----------------|------|-------|-------|
| Driver Strength | Full | 1 / 2 | 1 / 4 |
| IMPEDANCE(typ.) | 40Ω | 90Ω | 150Ω |

1. Impedance values are typical values, not 100% tested.

K1B3216B8E

OPERATION MODE (A/DQ[15]~A/DQ[14])

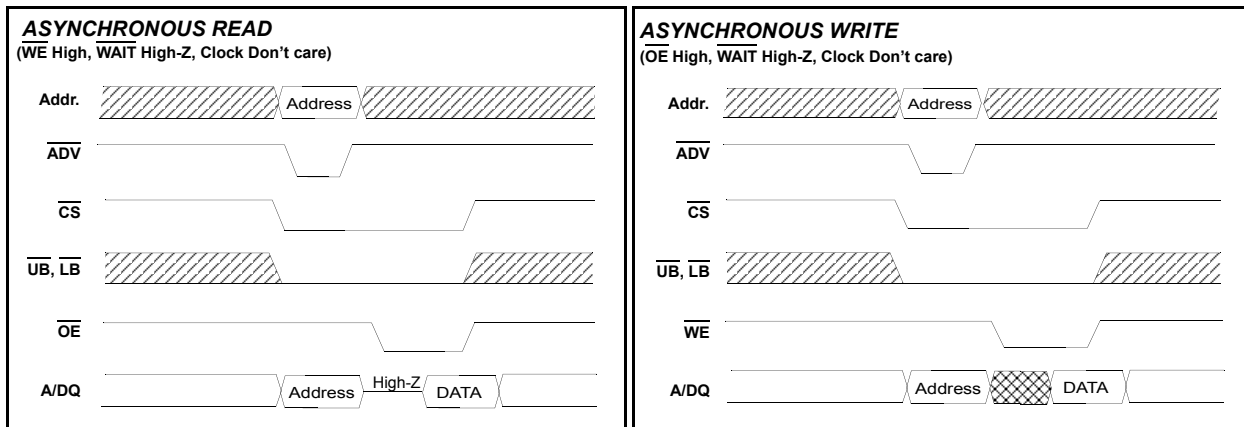
MODE1. ASYNCHRONOUS READ / ASYNCHRONOUS WRITE MODE

Asynchronous read operation

Asynchronous read operation starts when \overline{CS} , \overline{OE} and \overline{UB} or \overline{LB} are asserted. First data come out after random access time(tAA) but second, third and fourth data come out after page access time(tPA) when using the page addresses (A/DQ0, A/DQ1). \overline{PS} and \overline{WE} should be de-asserted during read operation. Clock is don't care during read operation and \overline{WAIT} is Hi-Z.

Asynchronous write operation

Asynchronous write operation starts when \overline{CS} , \overline{WE} and \overline{UB} or \overline{LB} are asserted. \overline{PS} and should be de-asserted during write operation. Clock, \overline{OE} are don't care during write operation and \overline{WAIT} signal is Hi-Z.



FUNCTIONAL DESCRIPTION

| \overline{CS} | \overline{OE} | \overline{WE} | \overline{LB} | \overline{UB} | \overline{ADV} | A/DQ0~15 | A16 ~ A20 | Mode | Power |
|-----------------|-----------------|-----------------|-----------------|-----------------|------------------|------------|-----------------|------------------|---------|
| H | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | High-Z | X ¹⁾ | Deselected | Standby |
| L | H | H | X ¹⁾ | X ¹⁾ | H | High-Z | X ¹⁾ | Output Disabled | Active |
| L | X ¹⁾ | X ¹⁾ | H | H | X ¹⁾ | High-Z | X ¹⁾ | Output Disabled | Active |
| L | H | H | H | H | [Pulse] | Add. Input | Add. Input | Address Input | Active |
| L | L | H | L | H | H | Dout | X ¹⁾ | Lower Byte Read | Active |
| L | L | H | H | L | H | Dout | X ¹⁾ | Upper Byte Read | Active |
| L | L | H | L | L | H | Dout | X ¹⁾ | Word Read | Active |
| L | H | L | L | H | H | Din | X ¹⁾ | Lower Byte Write | Active |
| L | H | L | H | L | H | Din | X ¹⁾ | Upper Byte Write | Active |
| L | H | L | L | L | H | Din | X ¹⁾ | Word Write | Active |

1. X means "Don't care". X should be low or high state.
2. In asynchronous mode, Clock is ignored. Clock should be low or high state.
3. \overline{WAIT} pin is High-Z in Asynchronous mode.

K1B3216B8E

MODE2. SYNCHRONOUS BURST READ / ASYNCHRONOUS WRITE MODE

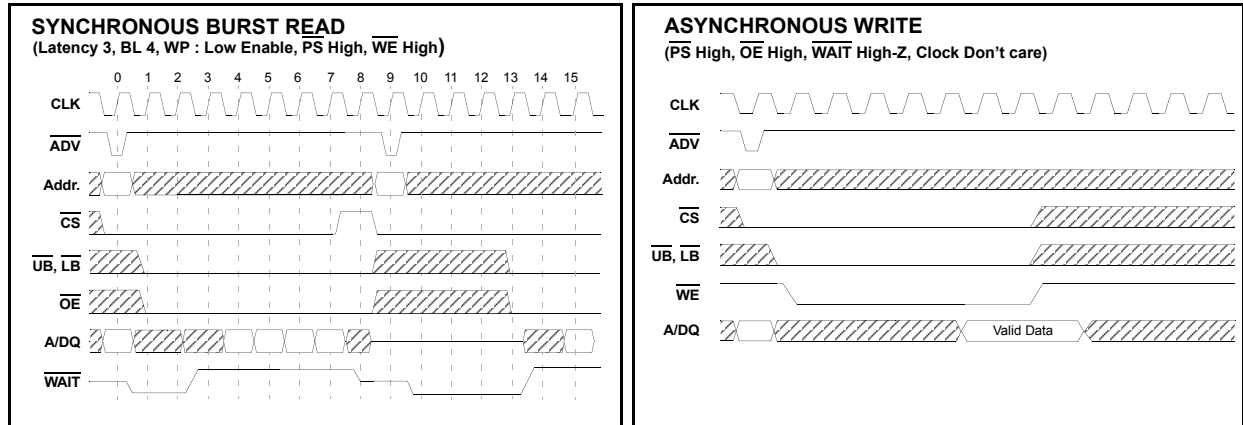
Synchronous Burst Read Operation

Burst Read command is implemented when \overline{ADV} is detected low at clock rising edge. \overline{WE} should be de-asserted during Burst read, Burst operation re-starts whenever \overline{ADV} is detected low at clock rising edge even in the middle of operation.

Variable latency allows the UTRAM to be configured for minimum latency at high frequencies, but the controller must monitor \overline{WAIT} to detect any conflict with refresh cycles.

Asynchronous Write Operation

Asynchronous write operation starts when \overline{CS} , \overline{WE} and \overline{UB} or \overline{LB} are asserted. \overline{PS} and should be de-asserted during write operation. Clock, \overline{OE} are don't care during write operation and \overline{WAIT} signal is Hi-Z.



FUNCTIONAL DESCRIPTION

| \overline{CS} | \overline{PS} | \overline{OE} | \overline{WE} | \overline{LB} | \overline{UB} | A/DQ0~7 | A/DQ8~15 | CLK | \overline{ADV} | Mode | Power |
|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|---------|----------|-----------------|------------------|------------------|---------|
| H | H | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | X ¹⁾ | Deselected | Standby |
| H | L | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | X ¹⁾ | Deselected | PAR |
| L | H | H | H | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | H | Output Disabled | Active |
| L | H | X ¹⁾ | X ¹⁾ | H | H | High-Z | High-Z | X ¹⁾ | H | Output Disabled | Active |
| L | H | X ¹⁾ | H | X ¹⁾ | X ¹⁾ | Address | Address | | | Read Command | Active |
| L | H | L | H | L | H | Dout | High-Z | | H | Lower Byte Read | Active |
| L | H | L | H | H | L | High-Z | Dout | | H | Upper Byte Read | Active |
| L | H | L | H | L | L | Dout | Dout | | H | Word Read | Active |
| L | H | H | L | L | H | Din | High-Z | X ¹⁾ | H | Lower Byte Write | Active |
| L | H | H | L | H | L | High-Z | Din | X ¹⁾ | H | Upper Byte Write | Active |
| L | H | H | L | L | L | Din | Din | X ¹⁾ | H | Word Write | Active |

1. X means "Don't care". X should be low or high state.

2. \overline{WAIT} is device output signal so does not have any affect to the mode definition. Please refer to each timing diagram for \overline{WAIT} pin function.

K1B3216B8E

MODE3. SYNCHRONOUS BURST READ / SYNCHRONOUS BURST WRITE MODE

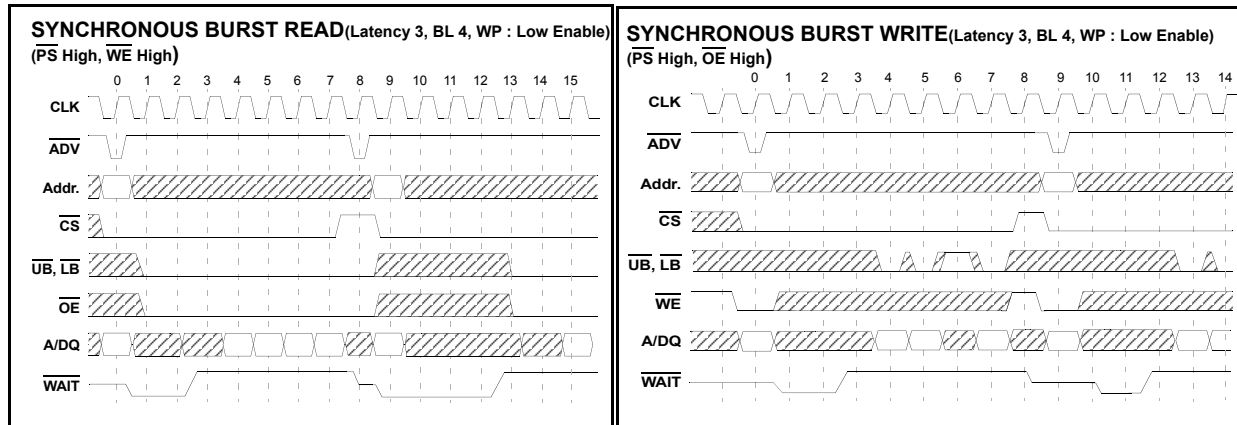
Synchronous Burst Read Operation

Burst Read command is implemented when \overline{ADV} is detected low at clock rising edge. \overline{WE} should be de-asserted during Burst read, Burst Read operation re-starts whenever \overline{ADV} is detected low at clock rising edge even in the middle of Burst Read operation. Variable latency allows the UTRAM to be configured for minimum latency at high frequencies, but the controller must monitor \overline{WAIT} to detect any conflict with refresh cycles.

Synchronous Burst Write Operation

Burst Write command is implemented when \overline{ADV} & \overline{WE} are detected low at clock rising edge. Burst Write operation re-starts whenever \overline{ADV} is detected low at clock rising edge even in the middle of Burst Write operation.

Write operations always use fixed latency.



FUNCTIONAL DESCRIPTION

| CS | PS | OE | WE | LB | UB | I/O0~7 | I/O8~15 | CLK | ADV | Mode | Power |
|----|----|-----------------|-----------------|-----------------|-----------------|--------|---------|-----------------|-----------------|------------------|---------|
| H | H | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | X ¹⁾ | Deselected | Standby |
| H | L | X ¹⁾ | X ¹⁾ | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | X ¹⁾ | Deselected | PAR |
| L | H | H | H | X ¹⁾ | X ¹⁾ | High-Z | High-Z | X ¹⁾ | H | Output Disabled | Active |
| L | H | X ¹⁾ | X ¹⁾ | H | H | High-Z | High-Z | X ¹⁾ | H | Output Disabled | Active |
| L | H | X ¹⁾ | H | X ¹⁾ | X ¹⁾ | High-Z | High-Z | ⌋ | ⌋ | Read Command | Active |
| L | H | L | H | L | H | Dout | High-Z | ⌋ | H | Lower Byte Read | Active |
| L | H | L | H | H | L | High-Z | Dout | ⌋ | H | Upper Byte Read | Active |
| L | H | L | H | L | L | Dout | Dout | ⌋ | H | Word Read | Active |
| L | H | X ¹⁾ | L | X ¹⁾ | X ¹⁾ | High-Z | High-Z | ⌋ | ⌋ | Write Command | Active |
| L | H | H | X ¹⁾ | L | H | Din | High-Z | ⌋ | H | Lower Byte Write | Active |
| L | H | H | X ¹⁾ | H | L | High-Z | Din | ⌋ | H | Upper Byte Write | Active |
| L | H | H | X ¹⁾ | L | L | Din | Din | ⌋ | H | Word Write | Active |

1. X means "Don't care". X should be low or high state.

2. /WAIT is device output signal so does not have any affect to the mode definition. Please refer to each timing diagram for /WAIT pin function.

MODE 1 AC OPERATING CONDITIONS (ASYNCH. READ / ASYNCH. WRITE)

TEST CONDITIONS

(Test Load and Test Input/Output Reference)

Input pulse level: 0.2 to V_{CCQ}-0.2V

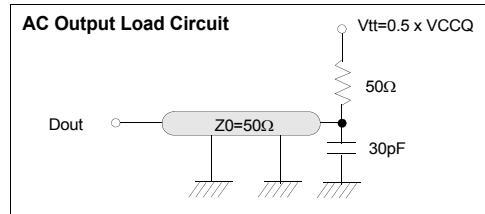
Input rising and falling time: 3ns

Input and output reference voltage: 0.5 x V_{CCQ}

Output load: CL=30pF

V_{CC}: 1.7V~1.95V

T_A: -40°C~85°C



AC CHARACTERISTICS

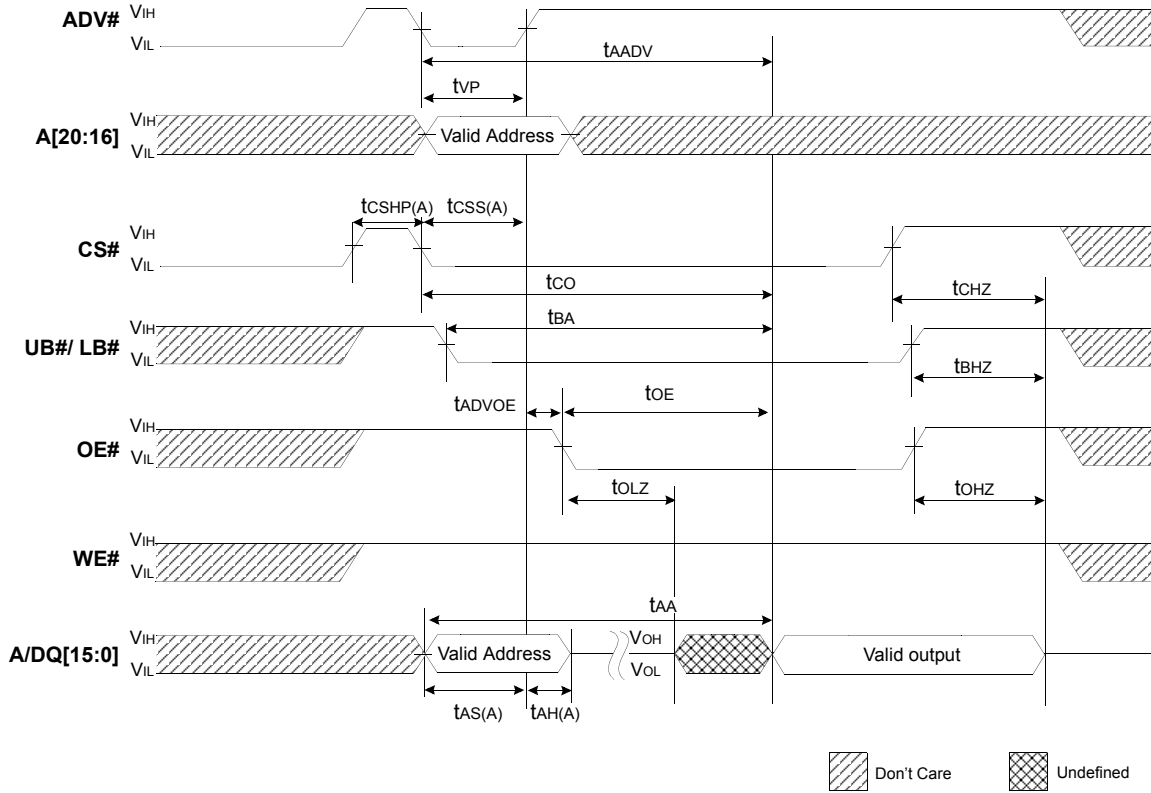
| Parameter List | | Symbol | Speed | | Units |
|--|---|----------|------------------|-----|-------|
| | | | Min | Max | |
| Common | $\overline{\text{CS}}$ High Pulse Width | tCSHP(A) | 10 | - | ns |
| | Address Set-up Time to $\overline{\text{ADV}}$ Rising | tAS(A) | 7 | - | ns |
| | Address Hold Time from $\overline{\text{ADV}}$ Rising | tAH(A) | 3 | - | ns |
| | $\overline{\text{ADV}}$ Pulse Width Low | tVP | 7 | - | ns |
| Asynch. Read | Address Access Time | tAA | - | 70 | ns |
| | $\overline{\text{ADV}}$ Access Time | tAADV | - | 70 | ns |
| | $\overline{\text{CS}}$ Setup Time to $\overline{\text{ADV}}$ Rising | tCSS(A) | 5 | - | ns |
| | Chip Select to Output | tCO | - | 70 | ns |
| | Output Enable to Valid Output | tOE | - | 20 | ns |
| | $\overline{\text{UB}}, \overline{\text{LB}}$ Access Time | tBA | - | 20 | ns |
| | Output Enable to Low-Z Output | tOLZ | 5 | - | ns |
| | Chip Disable to High-Z Output | tCHZ | 0 | 10 | ns |
| | $\overline{\text{UB}}, \overline{\text{LB}}$ Disable to High-Z Output | tBHZ | 0 | 10 | ns |
| | Output Disable to High-Z Output | tOHZ | 0 | 10 | ns |
| $\overline{\text{ADV}}$ High to $\overline{\text{OE}}$ Low | tADVOE | 5 | - | ns | |
| Asynch. Write | $\overline{\text{ADV}}$ Setup to end of Write | tVS | 70 | - | ns |
| | Chip Select to End of Write | tCW | 60 | - | ns |
| | Address Valid to End of Write | tAW | 60 | - | ns |
| | $\overline{\text{UB}}, \overline{\text{LB}}$ Valid to End of Write | tBW | 60 | - | ns |
| | Write Pulse Width | tWP | 55 ¹⁾ | - | ns |
| | Write Recovery Time | tWR | 0 | - | ns |
| | Data to Write Time Overlap | tDW | 20 | - | ns |
| | Data Hold from Write Time | tDH | 0 | - | ns |
| | $\overline{\text{CS}}$ Low to $\overline{\text{ADV}}$ High | tCVS | 7 | - | ns |
| | $\overline{\text{ADV}}$ High to $\overline{\text{WE}}$ Low | tADVWE | 5 | - | ns |

- tWP(min)=70ns for continuous write without CS toggling longer than 2.5us
- The High-Z timings measure a 100mV transition from either VOH or VOL toward VCCQ x 0.5
- The Low-Z timings measure a 100mV transition away from the High-Z level toward either VOH or VOL.

TIMING WAVEFORMS (ASYNCH. READ / ASYNCH. WRITE)

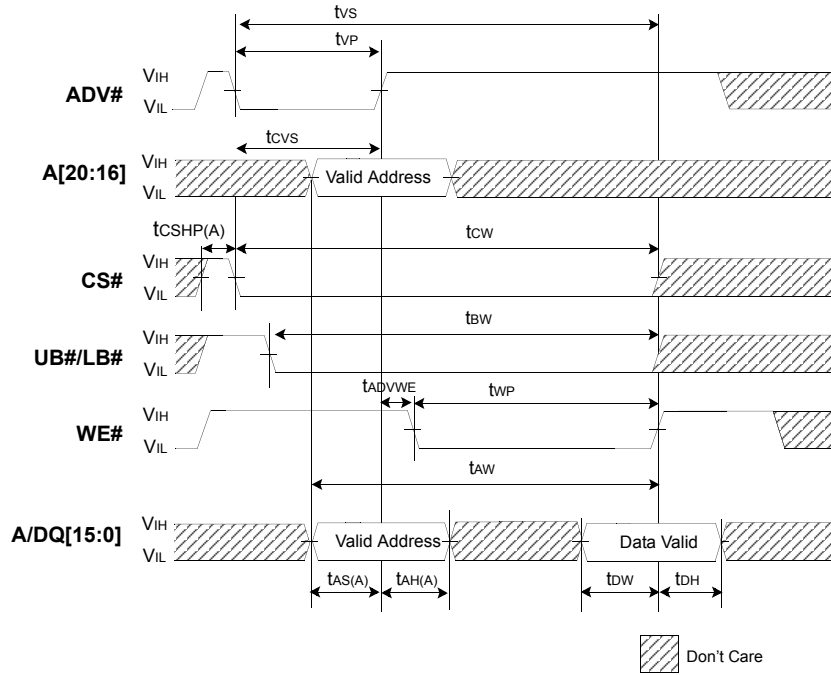
Asynch. READ

(PS=VIH, WE=VIH, WAIT=High-Z)



1. tCHZ and tOHZ are defined as the time when the outputs achieve the open circuit conditions and are not referenced to output voltage levels.
2. In asynchronous read cycle, Clock is ignored.

Asynchronous WRITE



Notes:

1. The end of the WRITE cycle is controlled by CE#, UB#/LB#, or WE#, whichever de-asserts first.

MODE 2 AC OPERATING CONDITIONS (SYNCH. READ / ASYNCH. WRITE)

TEST CONDITIONS

(Test Load and Test Input/Output Reference)

Input pulse level: 0.2 to V_{CCQ}-0.2V

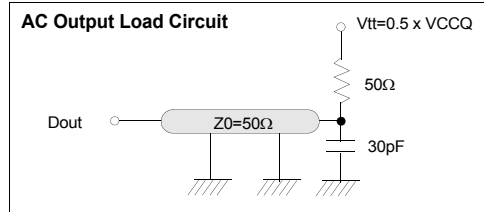
Input rising and falling time: 1ns

Input and output reference voltage: 0.5 x V_{CCQ}

Output load: C_L=30pF

V_{CC}: 1.7V~1.95V

T_A: -40°C~85°C



AC CHARACTERISTICS

| Parameter List | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|---|---------------------------------|-------|------|-------|------|--------|------|-------|
| | | Min | Max | Min | Max | Min | Max | |
| Clock Cycle Time | T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns |
| Burst Cycle Time | t _{BC} | - | 2500 | - | 2500 | - | 2500 | ns |
| Address Set-up Time to clock | t _{AS(B)} | 5 | - | 4 | - | 3 | - | ns |
| Address Hold Time from clock | t _{AH(B)} | 2 | - | 2 | - | 2 | - | ns |
| ADV Setup Time to clock | t _{ADVS} | 5 | - | 4 | - | 3 | - | ns |
| ADV Hold Time from clock | t _{ADVH} | 2 | - | 2 | - | 2 | - | ns |
| CS Setup Time to clock | t _{CSS(B)} | 5 | - | 4 | - | 3 | - | ns |
| CS High to ADV Low (Burst Stop) | t _{BsADV¹⁾} | 0 | - | 0 | - | 0 | - | ns |
| CS Low Hold Time from Clock(Burst Stop) | t _{CsLH} | 2 | - | 2 | - | 2 | - | ns |
| CS High Pulse Width | t _{CsHP} | 5 | - | 5 | - | 5 | - | ns |
| CS Low to WAIT Low | t _{WL} | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| Clock to WAIT High | t _{WH} | - | 11 | - | 9 | - | 7 | ns |
| CS High to WAIT High-Z | t _{WZ} | - | 10 | - | 10 | - | 10 | ns |
| UB, LB Low to End of Latency Clock | t _{BEL} | 20 | - | 20 | - | 20 | - | ns |
| OE Low to End of Latency Clock | t _{OEL} | 20 | - | 20 | - | 20 | - | ns |
| UB, LB Low to Low-Z Output | t _{B LZ} | 5 | - | 5 | - | 5 | - | ns |
| OE Low to Low-Z Output | t _{O LZ} | 5 | - | 5 | - | 5 | - | ns |
| Clock Rising to Data Output | t _{CD} | - | 11 | - | 9 | - | 7 | ns |
| Output Hold from clock | t _{OH(B)} | 3 | - | 3 | - | 3 | - | ns |
| Burst End Clock to Output High-Z | t _{HZ} | - | 10 | - | 10 | - | 10 | ns |
| CS High to Output High-Z | t _{CHZ} | - | 10 | - | 10 | - | 10 | ns |
| OE High to Output High-Z | t _{OHZ} | - | 10 | - | 10 | - | 10 | ns |
| UB, LB High to Output High-Z | t _{BHZ} | - | 10 | - | 10 | - | 10 | ns |
| ADV# high to OE# Low | t _{ADVO} | 5 | - | 4 | - | 3 | - | ns |

- Refresh can not be implemented when t_{BsADV} is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for t_{BsADV}.
- The High-Z timings measure a 100mV transition from either V_{OH} or V_{OL} toward V_{CCQ} x 0.5
- The Low-Z timings measure a 100mV transition away from the High-Z level toward either V_{OH} or V_{OL}.

| Parameter List | Symbol | Speed | | Units |
|-----------------------------------|---------------------|------------------|-----|-------|
| | | Min | Max | |
| Write Cycle Time | t _{WC} | 70 | - | ns |
| Chip Select to End of Write | t _{CW} | 60 | - | ns |
| ADV Minimum Low Pulse Width | t _{ADV} | 5 | - | ns |
| Address Set-up Time to ADV Rising | t _{AS(A)} | 5 | - | ns |
| Address Hold Time from ADV Rising | t _{AH(A)} | 3 | - | ns |
| CS Setup Time to ADV Rising | t _{CSS(A)} | 5 | - | ns |
| Address Valid to End of Write | t _{AW} | 60 | - | ns |
| UB, LB Valid to End of Write | t _{BW} | 60 | - | ns |
| Write Pulse Width | t _{WP} | 55 ¹⁾ | - | ns |
| Write Recovery Time | t _{WR} | 0 | - | ns |
| Data to Write Time Overlap | t _{DW} | 20 | - | ns |
| Data Hold from Write Time | t _{DH} | 0 | - | ns |
| ADV# HIGH to WE# LOW | t _{ADVWE} | 5 | - | ns |

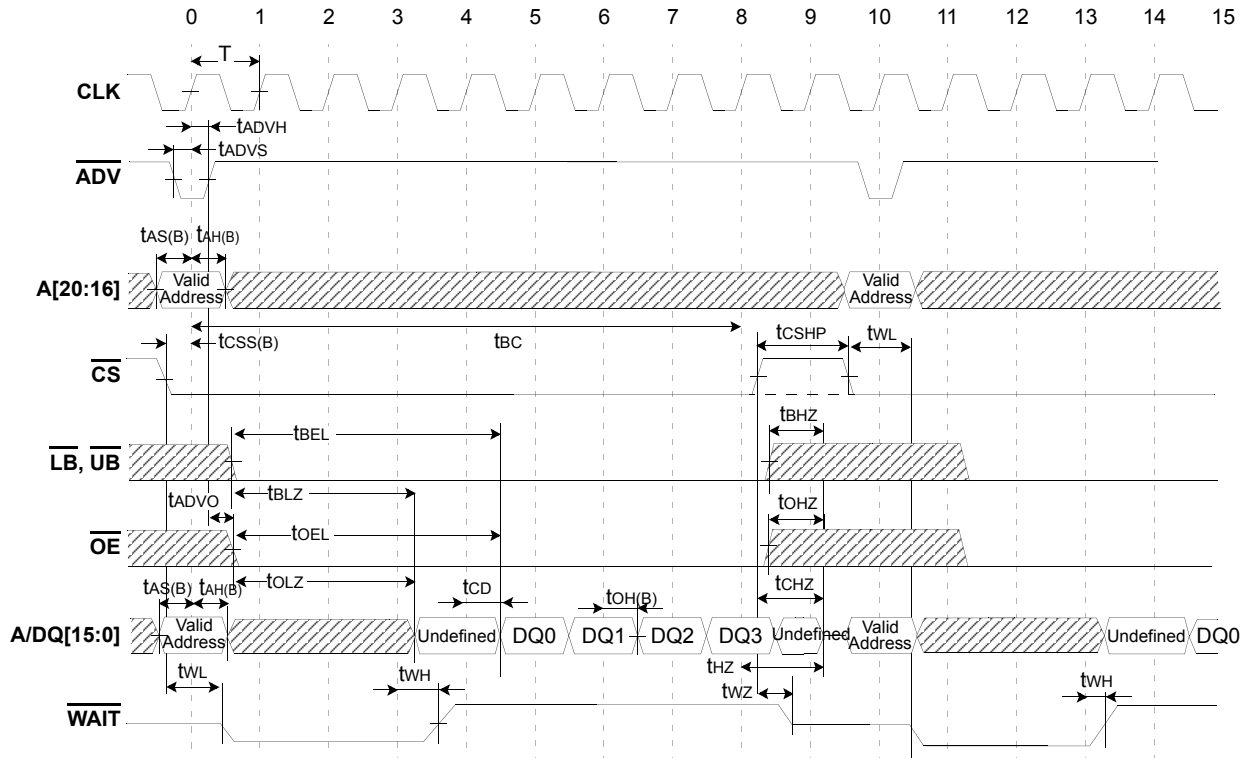
- t_{WP}(min)=70ns for continuous write longer than 2.5us without CS toggling.

K1B3216B8E

TIMING WAVEFORMS (SYNCH. READ / SYNCH. WRITE)

Burst READ - Fixed Latency

(PS=VIH, WE=VIH, WAIT=High-Z, Latency=4, Burst Length=4, WP=Low enable, WC=one clock prior to the data)



1. /WAIT Low(tWL) : Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(tWH) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(tWZ) : Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Burst operation should not be longer than tBC(2.5 μ s)

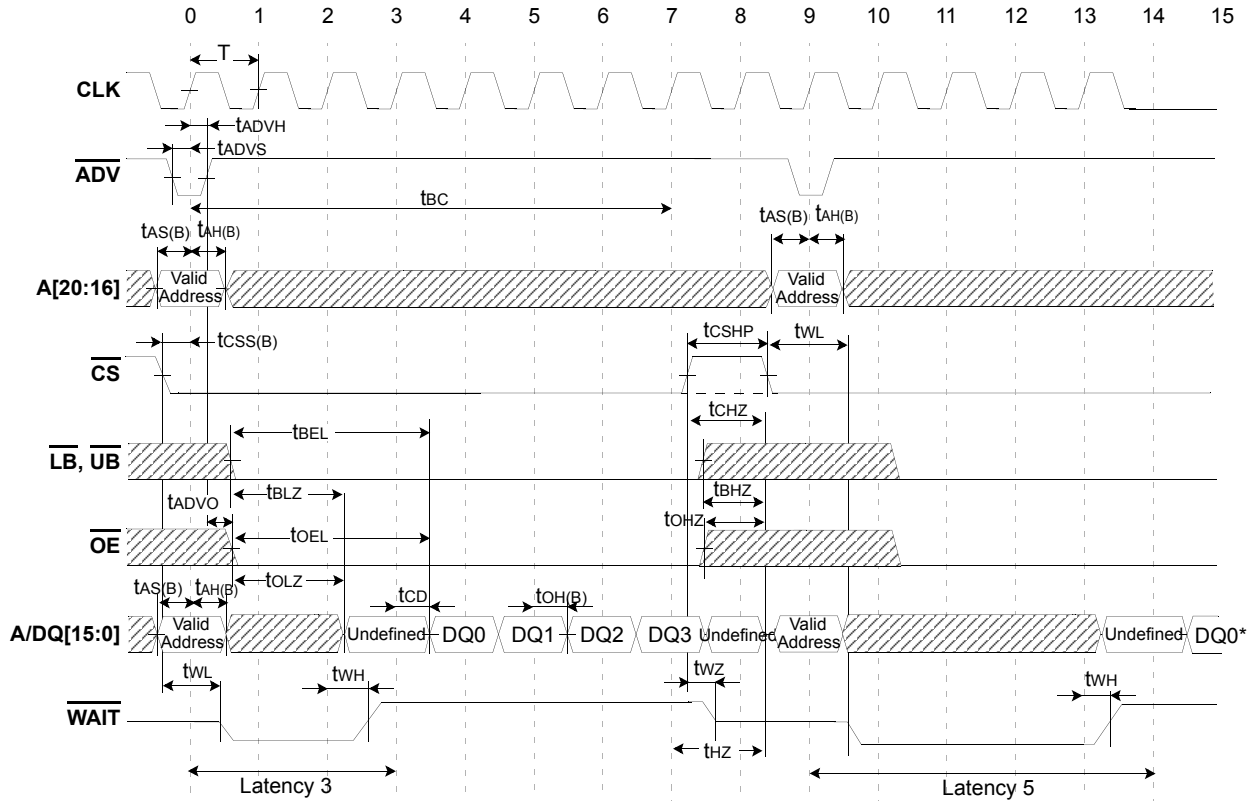
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|---------|-------|------|-------|------|--------|------|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns | tBLZ | 5 | - | 5 | - | 5 | - | ns |
| tBC | - | 2500 | - | 2500 | - | 2500 | ns | tOLZ | 5 | - | 5 | - | 5 | - | ns |
| tADVS | 5 | - | 4 | - | 3 | - | ns | tHZ | - | 10 | - | 10 | - | 10 | ns |
| tADVH | 2 | - | 2 | - | 2 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tAS(B) | 5 | - | 4 | - | 3 | - | ns | tOHZ | - | 10 | - | 10 | - | 10 | ns |
| tAH(B) | 2 | - | 2 | - | 2 | - | ns | tBHZ | - | 10 | - | 10 | - | 10 | ns |
| tcSS(B) | 5 | - | 4 | - | 3 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tWZ | - | 10 | - | 10 | - | 10 | ns | tADVO | 5 | - | 4 | - | 3 | - | ns |

K1B3216B8E

Burst READ - Variable Latency

(PS=VIH, WE=VIH, Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



1. Delayed Latency should be taken increased when refresh is required. Refer to Latency Table.
2. /WAIT Low(tWL) : Data not available(driven by CS low going edge or ADV low going edge)
/WAIT High(tWH) : Data available(driven by Latency-1 clock)
/WAIT High-Z(tWZ) : Data don't care(driven by CS high going edge)
3. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
4. Burst operation should not be longer than tBC(2.5µs).

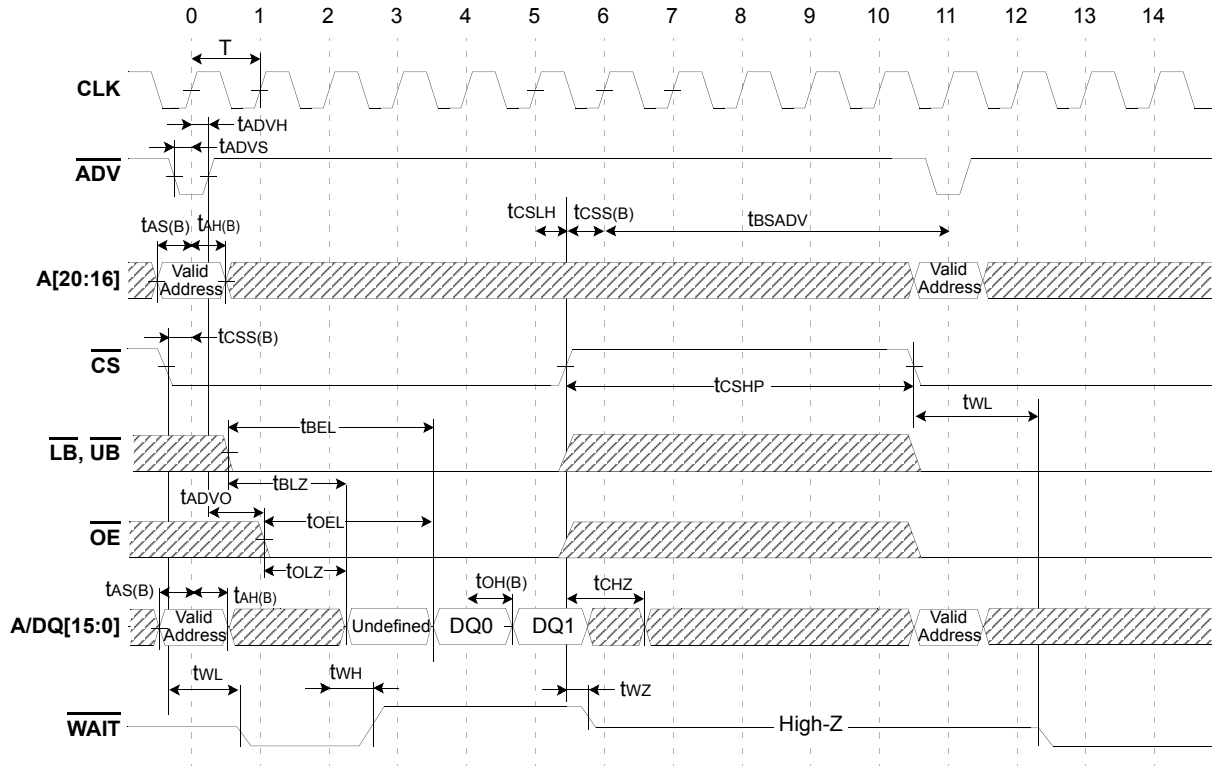
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|---------|-------|------|-------|------|--------|------|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns | tBLZ | 5 | - | 5 | - | 5 | - | ns |
| tBC | - | 2500 | - | 2500 | - | 2500 | ns | tOLZ | 5 | - | 5 | - | 5 | - | ns |
| tADVS | 5 | - | 4 | - | 3 | - | ns | tHZ | - | 10 | - | 10 | - | 10 | ns |
| tADVH | 2 | - | 2 | - | 2 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tAS(B) | 5 | - | 4 | - | 3 | - | ns | tOHZ | - | 10 | - | 10 | - | 10 | ns |
| tAH(B) | 2 | - | 2 | - | 2 | - | ns | tBHZ | - | 10 | - | 10 | - | 10 | ns |
| tCSS(B) | 5 | - | 4 | - | 3 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tWZ | - | 10 | - | 10 | - | 10 | ns | tADVO | 5 | - | 4 | - | 3 | - | ns |

K1B3216B8E

Burst READ STOP

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



1. /WAIT Low(tWL) : Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(tWH) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(tWZ) : Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Refresh can not be implemented when tBSADV is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without \overline{CS} toggling. To avoid Refresh fail, 13ns for all frequency is needed for tBSADV.

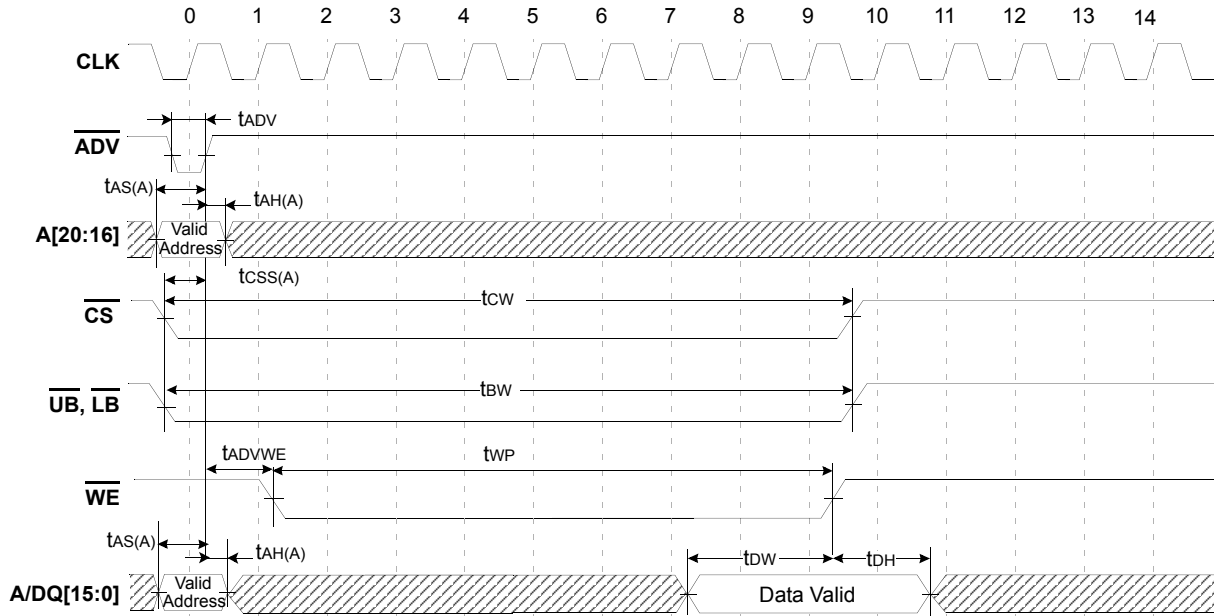
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|--------|-------|-----|-------|-----|--------|-----|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| tBSADV | 0 | - | 0 | - | 0 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSLH | 2 | - | 2 | - | 2 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tBLZ | 5 | - | 5 | - | 5 | - | ns | tWZ | - | 10 | - | 10 | - | 10 | ns |
| tOLZ | 5 | - | 5 | - | 5 | - | ns | tADVO | 5 | - | 4 | - | 3 | - | ns |

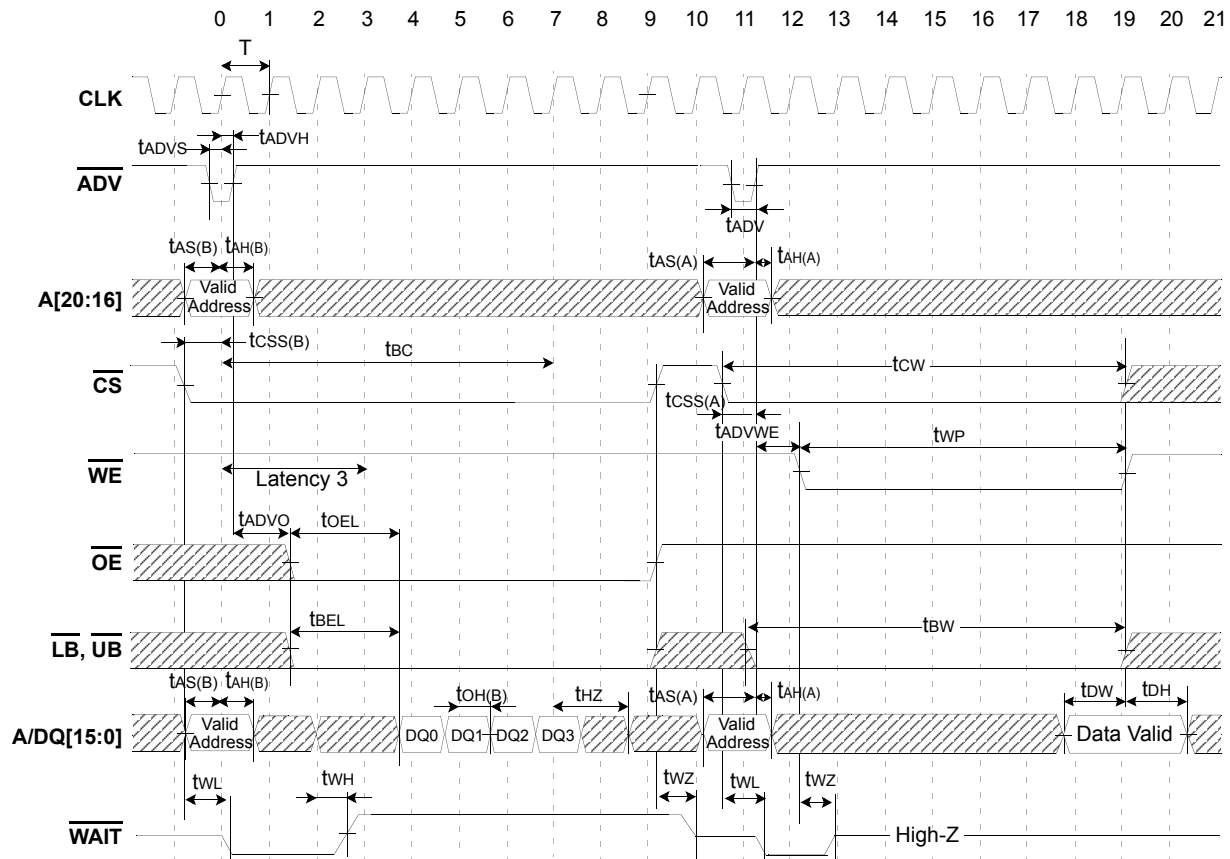
K1B3216B8E

Asynch. WRITE

(PS=VIH, OE=VIH, WAIT=High-Z)



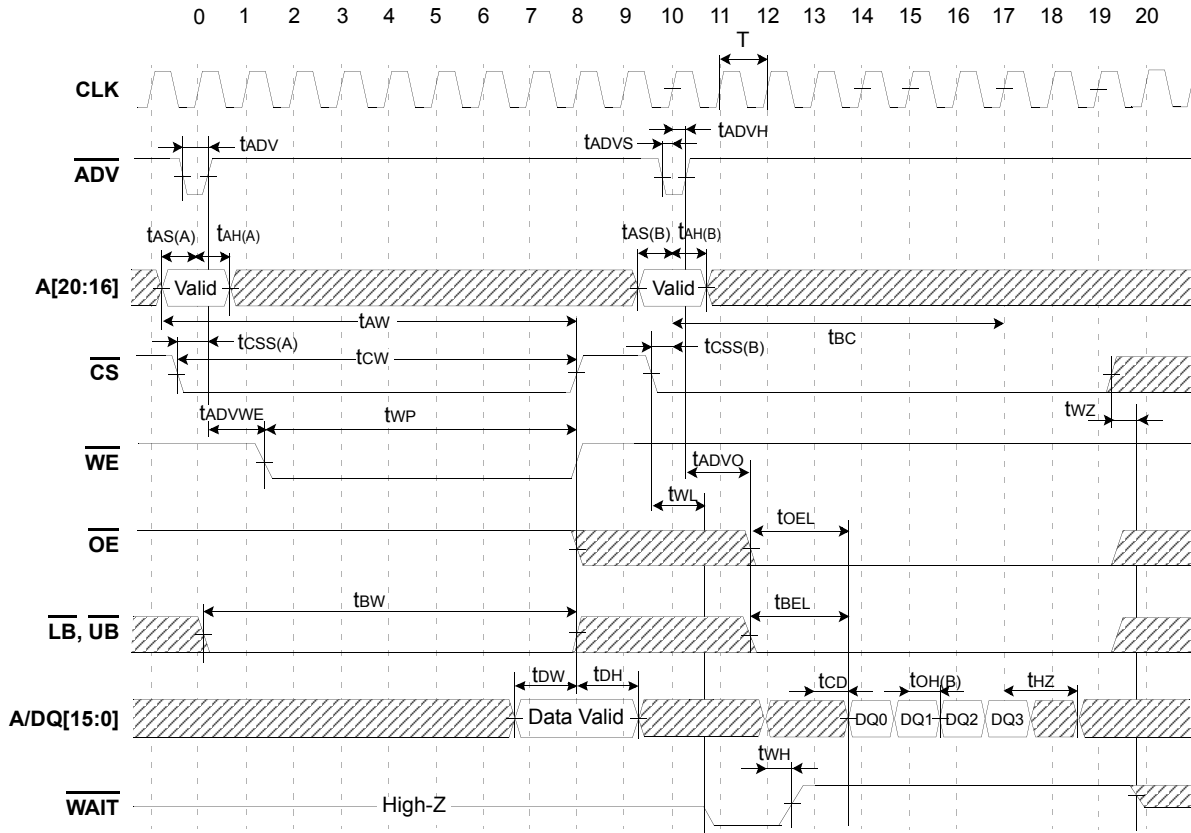
Burst READ followed by Asynch. WRITE
 (PS=VIH, WAIT=High-Z, Variable Latency=3)



1. A write occurs during the overlap(t_{WP}) of low \overline{CS} and low \overline{WE} . A write begins when \overline{CS} goes low and \overline{WE} goes low with asserting \overline{UB} or \overline{LB} for single byte operation or simultaneously asserting \overline{UB} and \overline{LB} for word operation. A write ends at the earliest transition when \overline{CS} goes high or \overline{WE} goes high. The t_{WP} is measured from the beginning of write to the end of write.
2. t_{AW} is measured from the address valid to the end of write. In this address latch type write timing, t_{WC} is same as t_{AW} .
3. t_{CW} is measured from the \overline{CS} going low to the end of write.
4. t_{W} is measured from the \overline{UB} and \overline{LB} going low to the end of write.

Asynch. WRITE followed by Burst READ

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)

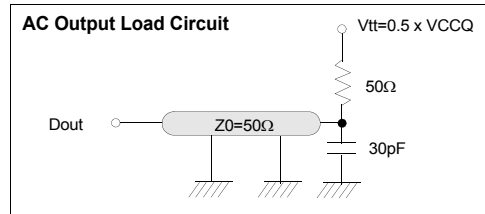


1. /WAIT Low(t_{WL}): Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(t_{WH}): Data available(driven by Latency-1 clock)
 /WAIT High-Z(t_{WZ}): Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Burst operation should not be longer than t_{BC} (2.5 μ s)

MODE3. AC OPERATING CONDITIONS (SYNCH. READ / SYNCH. WRITE)

TEST CONDITIONS

(Test Load and Test Input/Output Reference)
 Input pulse level: 0.2 to Vcc-0.2V
 Input rising and falling time: 1ns
 Input and output reference voltage: 0.5 x Vcc
 Output load: CL=30pF
 Vcc:1.7V~1.95V
 TA: -40°C~85°C



AC CHARACTERISTICS

| Parameter List | Symbol | 66MHz | | 80MHz | | 104MHz | | Units | |
|--|---|--------------------|-----|-------|------|--------|-----|-------|----|
| | | Min | Max | Min | Max | Min | Max | | |
| Burst Operation (Common) | Clock Cycle Time | T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns |
| | Burst Cycle Time | t _{BC} | - | 2500 | - | 2500 | - | 2500 | ns |
| | Address Set-up Time to clock | t _{AS(B)} | 5 | - | 4 | - | 3 | - | ns |
| | Address Hold Time from clock | t _{AH(B)} | 2 | - | 2 | - | 2 | - | ns |
| | \overline{ADV} Setup Time to clock | t _{ADVS} | 5 | - | 4 | - | 3 | - | ns |
| | \overline{ADV} Hold Time from clock | t _{ADVH} | 2 | - | 2 | - | 2 | - | ns |
| | \overline{CS} Setup Time to clock | t _{CS(S)} | 5 | - | 4 | - | 3 | - | ns |
| | \overline{CS} High to New \overline{ADV} Low (Burst Stop) | t _{BSADV} | 0 | - | 0 | - | 0 | - | ns |
| | \overline{CS} Low Hold Time from Clock(Burst Stop) | t _{CSLH} | 2 | - | 2 | - | 2 | - | ns |
| | \overline{CS} High Pulse Width | t _{CSHP} | 5 | - | 5 | - | 5 | - | ns |
| | \overline{CS} Low to \overline{WAIT} Low | t _{WL} | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| | Clock to \overline{WAIT} High | t _{WH} | - | 11 | - | 9 | - | 7 | ns |
| Burst Read Operation | $\overline{UB}, \overline{LB}$ Low to End of Latency Clock | t _{BEL} | 20 | - | 20 | - | 20 | - | ns |
| | \overline{OE} Low to End of Latency Clock | t _{OEL} | 20 | - | 20 | - | 20 | - | ns |
| | $\overline{UB}, \overline{LB}$ Low to Low-Z Output | t _{B LZ} | 5 | - | 5 | - | 5 | - | ns |
| | \overline{OE} Low to Low-Z Output | t _{O LZ} | 5 | - | 5 | - | 5 | - | ns |
| | Clock Rising to Data Output | t _{CD} | - | 11 | - | 9 | - | 7 | ns |
| | Output Hold from clock | t _{OH(B)} | 3 | - | 3 | - | 3 | - | ns |
| | Burst End Clock to Output High-Z | t _{HZ} | - | 10 | - | 10 | - | 10 | ns |
| | \overline{CS} High to Output High-Z | t _{CHZ} | - | 10 | - | 10 | - | 10 | ns |
| | \overline{OE} High to Output High-Z | t _{OHZ} | - | 10 | - | 10 | - | 10 | ns |
| | $\overline{UB}, \overline{LB}$ High to Output High-Z | t _{BHZ} | - | 10 | - | 10 | - | 10 | ns |
| \overline{ADV} high to \overline{OE} Low | t _{ADVO} | 5 | - | 4 | - | 3 | - | ns | |

1. Refresh can not be implemented when t_{BSADV} is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for t_{BSADV}.
2. The High-Z timings measure a 100mV transition from either VOH or VOL toward VCCQ x 0.5
3. The Low-Z timings measure a 100mV transition away from the High-Z level toward either VOH or VOL.

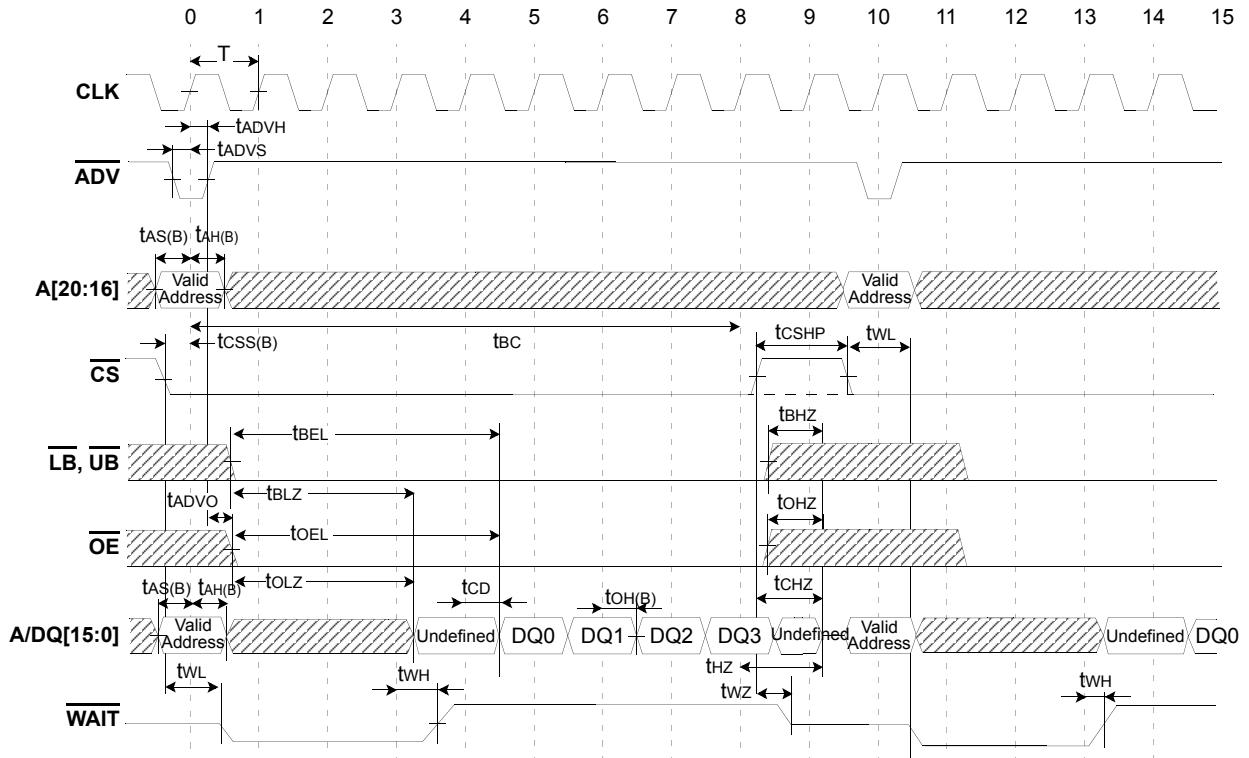
| | | | | | | | | | |
|---------------------------------|---|--------------------|---|---|---|---|---|----|----|
| Burst Write Operation | \overline{WE} Set-up Time to Clock | t _{WES} | 5 | - | 4 | - | 3 | - | ns |
| | \overline{WE} Hold Time from Clock | t _{WEH} | 2 | - | 2 | - | 2 | - | ns |
| | $\overline{UB}, \overline{LB}$ Set-up Time to Clock | t _{BS} | 5 | - | 4 | - | 3 | - | ns |
| | Burst End clock to New \overline{ADV} Low | t _{BEADV} | 0 | - | 0 | - | 0 | - | ns |
| | $\overline{UB}, \overline{LB}$ Hold Time from Clock | t _{BH} | 2 | - | 2 | - | 2 | - | ns |
| | Byte Masking Set-up Time to Clock | t _{BMS} | 5 | - | 4 | - | 3 | - | ns |
| | Byte Masking Hold Time from Clock | t _{BMH} | 2 | - | 2 | - | 2 | - | ns |
| | Write Data Set-up Time to Clock | t _{DS} | 5 | - | 4 | - | 3 | - | ns |
| Write Data Hold Time from Clock | t _{DHC} | 2 | - | 2 | - | 2 | - | ns | |

1. Refresh can not be implemented when t_{BEADV} is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for t_{BEADV}.

TIMING WAVEFORMS (SYNCH. READ / SYNCH. WRITE)

Burst READ - Fixed Latency

(PS=VIH, WE=VIH, WAIT=High-Z, Latency=4, Burst Length=4, WP=Low enable, WC=one clock prior to the data)



1. /WAIT Low(tWL) : Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(tWH) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(tWZ) : Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Burst operation should not be longer than tBC(2.5µs)

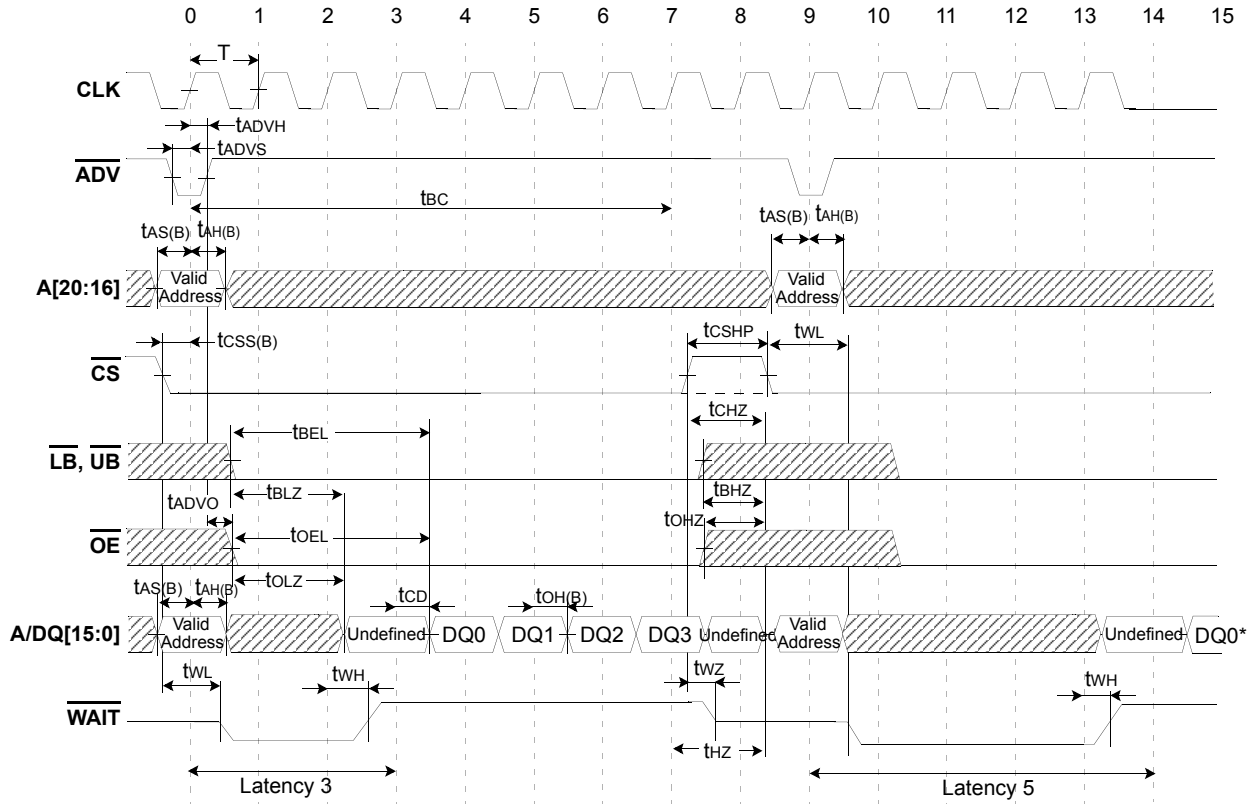
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|---------|-------|------|-------|------|--------|------|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns | tBLZ | 5 | - | 5 | - | 5 | - | ns |
| tBC | - | 2500 | - | 2500 | - | 2500 | ns | tOLZ | 5 | - | 5 | - | 5 | - | ns |
| tADVS | 5 | - | 4 | - | 3 | - | ns | tHZ | - | 10 | - | 10 | - | 10 | ns |
| tADVH | 2 | - | 2 | - | 2 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tAS(B) | 5 | - | 4 | - | 3 | - | ns | tOHZ | - | 10 | - | 10 | - | 10 | ns |
| tAH(B) | 2 | - | 2 | - | 2 | - | ns | tBHZ | - | 10 | - | 10 | - | 10 | ns |
| tCSS(B) | 5 | - | 4 | - | 3 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tWZ | - | 10 | - | 10 | - | 10 | ns | tADVO | 5 | - | 4 | - | 3 | - | ns |

K1B3216B8E

Burst READ - Variable Latency

(PS=VIH, WE=VIH, Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



1. Delayed Latency should be taken increased when refresh is required. Refer to Latency Table.
2. /WAIT Low(tWL) : Data not available(driven by CS low going edge or ADV low going edge)
/WAIT High(tWH) : Data available(driven by Latency-1 clock)
/WAIT High-Z(tWZ) : Data don't care(driven by CS high going edge)
3. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
4. Burst operation should not be longer than tBC(2.5µs).

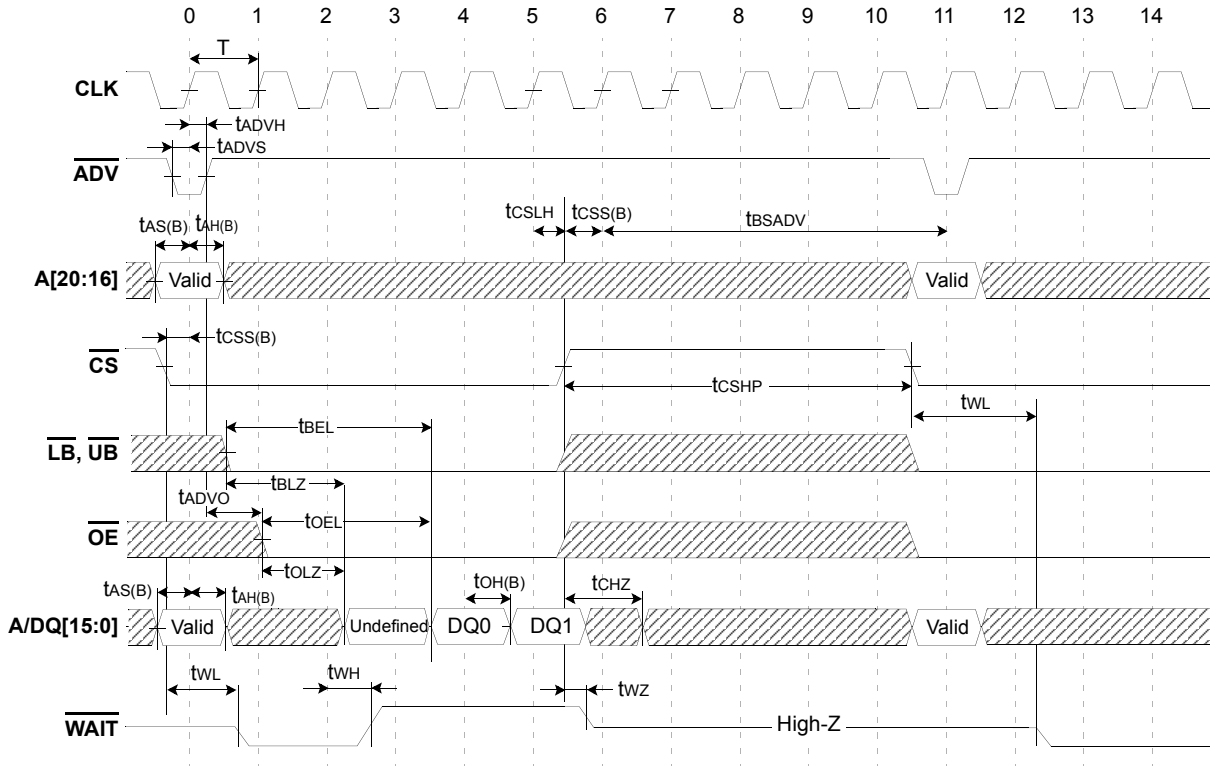
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|---------|-------|------|-------|------|--------|------|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| T | 15 | 200 | 12.5 | 200 | 9.6 | 200 | ns | tBLZ | 5 | - | 5 | - | 5 | - | ns |
| tBC | - | 2500 | - | 2500 | - | 2500 | ns | tOLZ | 5 | - | 5 | - | 5 | - | ns |
| tADVS | 5 | - | 4 | - | 3 | - | ns | tHZ | - | 10 | - | 10 | - | 10 | ns |
| tADVH | 2 | - | 2 | - | 2 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tAS(B) | 5 | - | 4 | - | 3 | - | ns | tOHZ | - | 10 | - | 10 | - | 10 | ns |
| tAH(B) | 2 | - | 2 | - | 2 | - | ns | tBHZ | - | 10 | - | 10 | - | 10 | ns |
| tCSS(B) | 5 | - | 4 | - | 3 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSPH | 5 | - | 5 | - | 5 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tWZ | - | 10 | - | 10 | - | 10 | ns | tADVO | 5 | - | 4 | - | 3 | - | ns |

K1B3216B8E

Burst READ STOP

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



1. /WAIT Low(tWL) : Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(tWH) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(tWZ) : Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Refresh can not be implemented when tBSADV is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without \overline{CS} toggling. To avoid Refresh fail, 13ns for all frequency is needed for tBSADV.

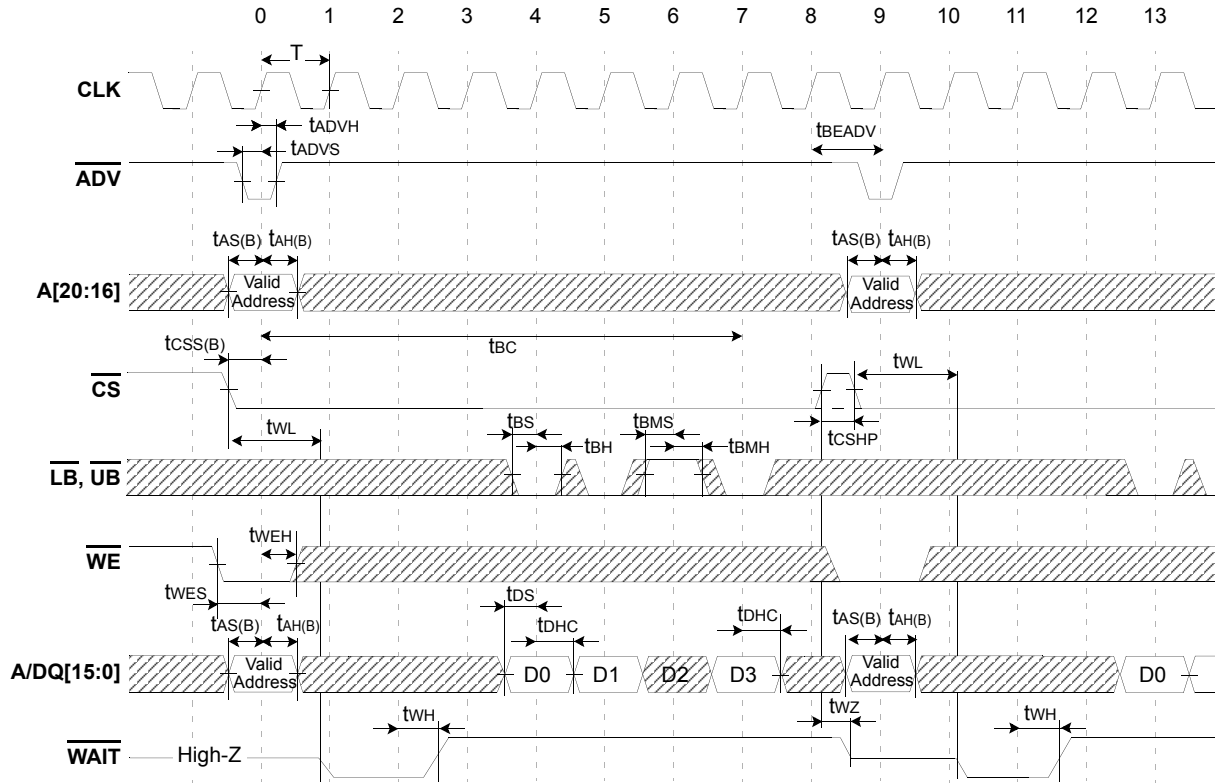
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|--------|-------|-----|-------|-----|--------|-----|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| tBSADV | 0 | - | 0 | - | 0 | - | ns | tCD | - | 11 | - | 9 | - | 7 | ns |
| tCSLH | 2 | - | 2 | - | 2 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tCHZ | - | 10 | - | 10 | - | 10 | ns |
| tBEL | 20 | - | 20 | - | 20 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tOEL | 20 | - | 20 | - | 20 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tBLZ | 5 | - | 5 | - | 5 | - | ns | tWZ | - | 10 | - | 10 | - | 10 | ns |
| tOLZ | 5 | - | 5 | - | 5 | - | ns | | | | | | | | |

K1B3216B8E

Burst WRITE

(PS=VIH, OE=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



1. Refresh can not be implemented when t_{BEADV} is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for t_{BEADV} .
2. /WAIT Low(t_{WL}): Data not available(driven by CS low going edge or ADV low going edge)
/WAIT High(t_{WH}): Data available(driven by Latency-1 clock)
/WAIT High-Z(t_{WZ}): Data don't care(driven by CS high going edge)
3. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising. The data starts after set Latency from the last clock rising.
4. Burst operation should not be longer than t_{BC} (2.5us)

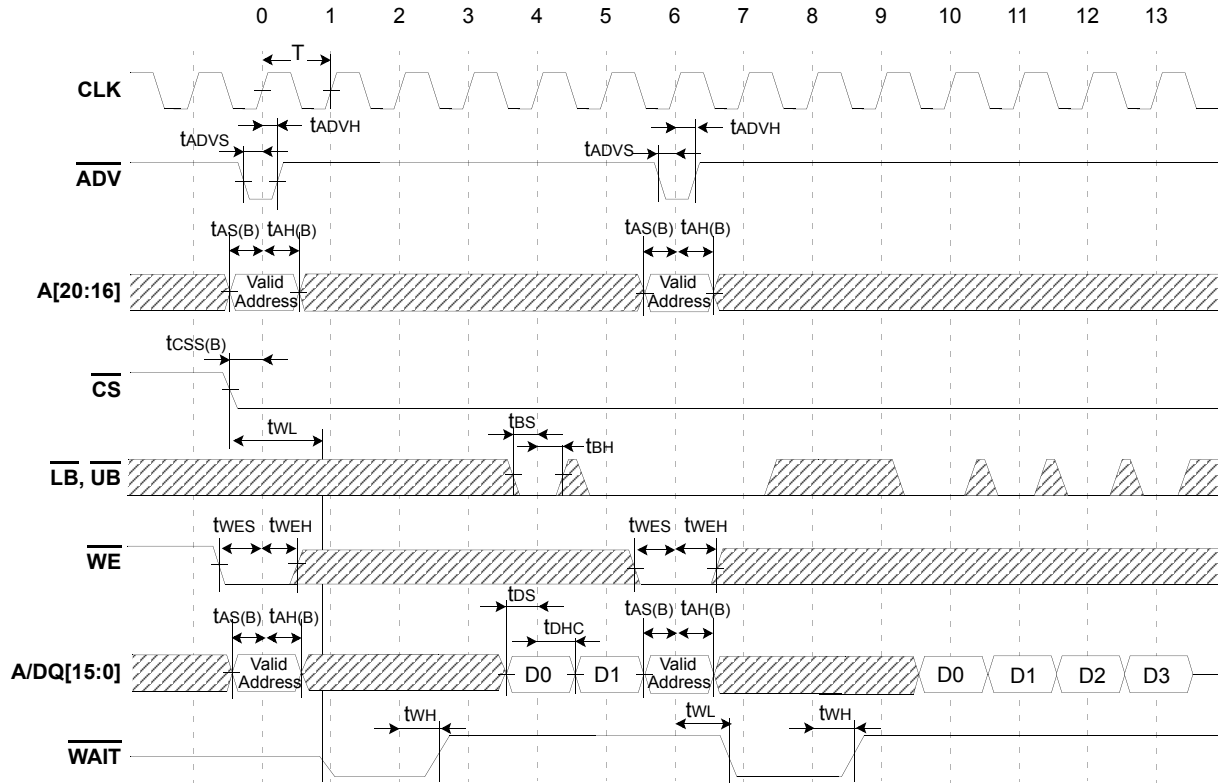
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|------------|-------|-----|-------|-----|--------|-----|-------|-----------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| t_{CSSH} | 5 | - | 5 | - | 5 | - | ns | t_{DS} | 3 | - | 3 | - | 3 | - | ns |
| t_{BS} | 5 | - | 4 | - | 3 | - | ns | t_{DHC} | 2 | - | 2 | - | 2 | - | ns |
| t_{BH} | 2 | - | 2 | - | 2 | - | ns | t_{WL} | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| t_{BMS} | 5 | - | 4 | - | 3 | - | ns | t_{WH} | - | 11 | - | 9 | - | 7 | ns |
| t_{BMH} | 2 | - | 2 | - | 2 | - | ns | t_{WZ} | - | 10 | - | 10 | - | 10 | ns |
| t_{WES} | 5 | - | 4 | - | 3 | - | ns | | | | | | | | |
| t_{WEH} | 2 | - | 2 | - | 2 | - | ns | | | | | | | | |

K1B3216B8E

Burst WRITE (ADV PULSE Interrupt)

(PS=VIH, OE=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



- Multiple clock risings are allowed during low \overline{ADV} period. The data starts after set Latency from the last clock rising.
- \overline{WAIT} Low (t_{WL}): Data not available (driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 \overline{WAIT} High (t_{WH}): Data available (driven by Latency-1 clock)
 \overline{WAIT} High-Z (t_{WZ}): Data don't care (driven by \overline{CS} high going edge)
- Burst interrupt is allowable after the first data word written.

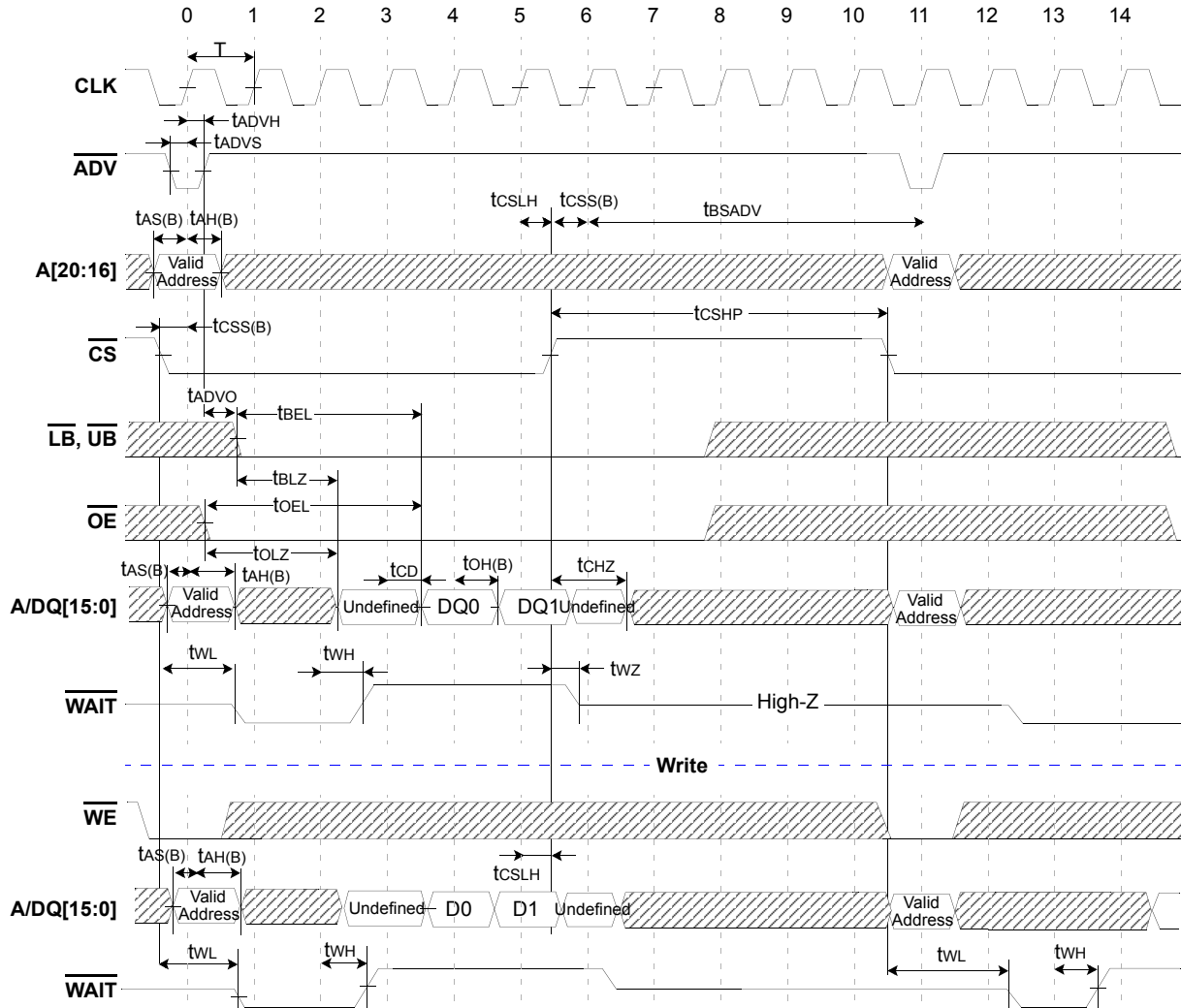
AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|------------|-------|-----|-------|-----|--------|-----|-------|-----------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| t_{CSHP} | 5 | - | 5 | - | 5 | - | ns | t_{DS} | 5 | - | 4 | - | 3 | - | ns |
| t_{BS} | 5 | - | 4 | - | 3 | - | ns | t_{DHC} | 2 | - | 2 | - | 2 | - | ns |
| t_{BH} | 2 | - | 2 | - | 2 | - | ns | t_{WL} | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| t_{BMS} | 5 | - | 4 | - | 3 | - | ns | t_{WH} | - | 11 | - | 9 | - | 7 | ns |
| t_{BMH} | 2 | - | 2 | - | 2 | - | ns | t_{WZ} | - | 10 | - | 10 | - | 10 | ns |
| t_{WES} | 5 | - | 4 | - | 3 | - | ns | | | | | | | | |
| t_{WEH} | 2 | - | 2 | - | 2 | - | ns | | | | | | | | |

K1B3216B8E

Burst READ STOP & Burst WRITE STOP

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)



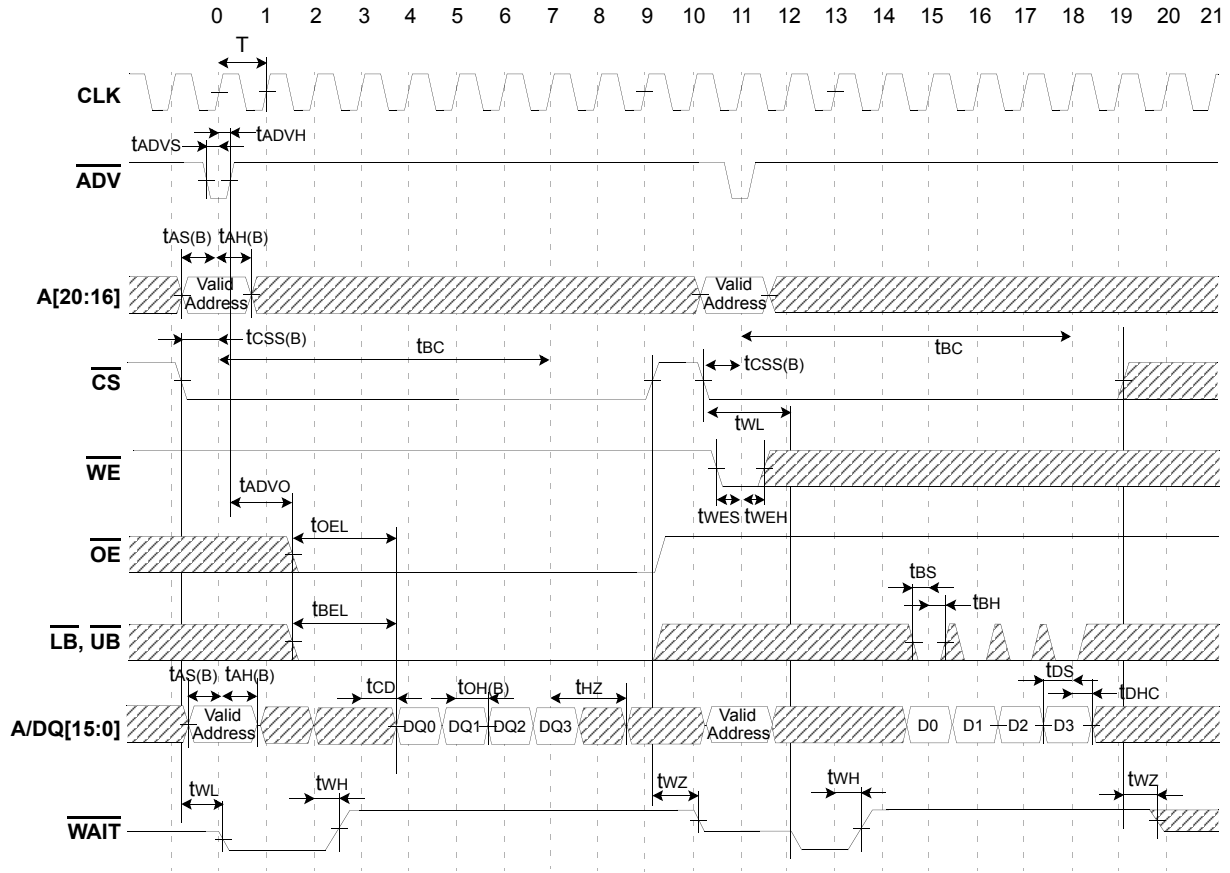
1. Refresh can not be implemented when tBEADV is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for tBEADV.
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. /WAIT Low(tWL) : Data not available(driven by CS low going edge or ADV low going edge)
 /WAIT High(tWH) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(tWZ) : Data don't care(driven by CS high going edge)

AC CHARACTERISTICS

| Symbol | 66MHz | | 80MHz | | 104MHz | | Units | Symbol | 66MHz | | 80MHz | | 104MHz | | Units |
|--------|-------|-----|-------|-----|--------|-----|-------|--------|-------|-----|-------|-----|--------|-----|-------|
| | Min | Max | Min | Max | Min | Max | | | Min | Max | Min | Max | Min | Max | |
| tCSHP | 5 | - | 5 | - | 5 | - | ns | tDS | 5 | - | 4 | - | 3 | - | ns |
| tBS | 5 | - | 4 | - | 3 | - | ns | tDHC | 2 | - | 2 | - | 2 | - | ns |
| tBH | 2 | - | 2 | - | 2 | - | ns | tWL | - | 7.5 | - | 7.5 | - | 7.5 | ns |
| tBMS | 5 | - | 4 | - | 3 | - | ns | tWH | - | 11 | - | 9 | - | 7 | ns |
| tBMH | 2 | - | 2 | - | 2 | - | ns | tWZ | - | 10 | - | 10 | - | 10 | ns |
| tWES | 5 | - | 4 | - | 3 | - | ns | tBSADV | - | 0 | - | 0 | - | 0 | ns |
| tWEH | 2 | - | 2 | - | 2 | - | ns | tOH(B) | 3 | - | 3 | - | 3 | - | ns |

Burst READ followed by Burst WRITE

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)

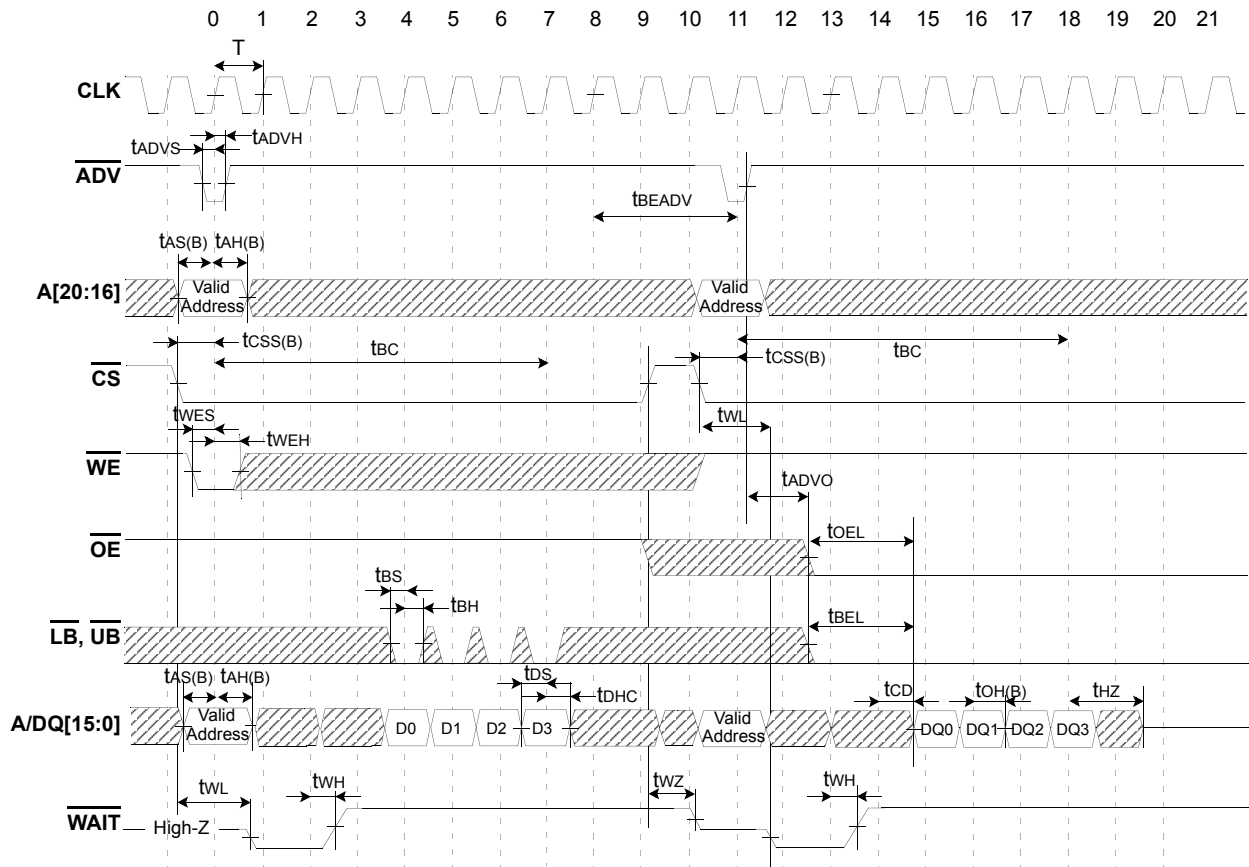


1. /WAIT Low(t_{WL}) : Data not available(driven by \overline{CS} low going edge or \overline{ADV} low going edge)
 /WAIT High(t_{WH}) : Data available(driven by Latency-1 clock)
 /WAIT High-Z(t_{WZ}) : Data don't care(driven by \overline{CS} high going edge)
2. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
3. Burst operation should not be longer than t_{BC} (2.5 μ s)

K1B3216B8E

Burst WRITE followed by Burst READ

(PS=VIH, Variable Latency=3, Burst Length=4, WP=Low Enable, WC=one clock prior to the data)

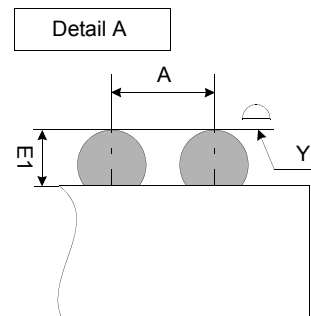
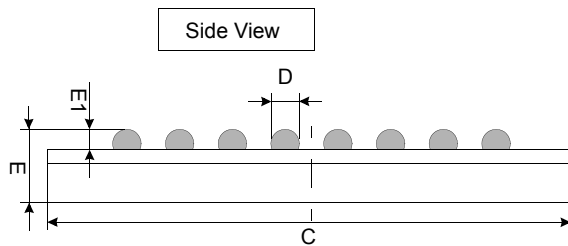
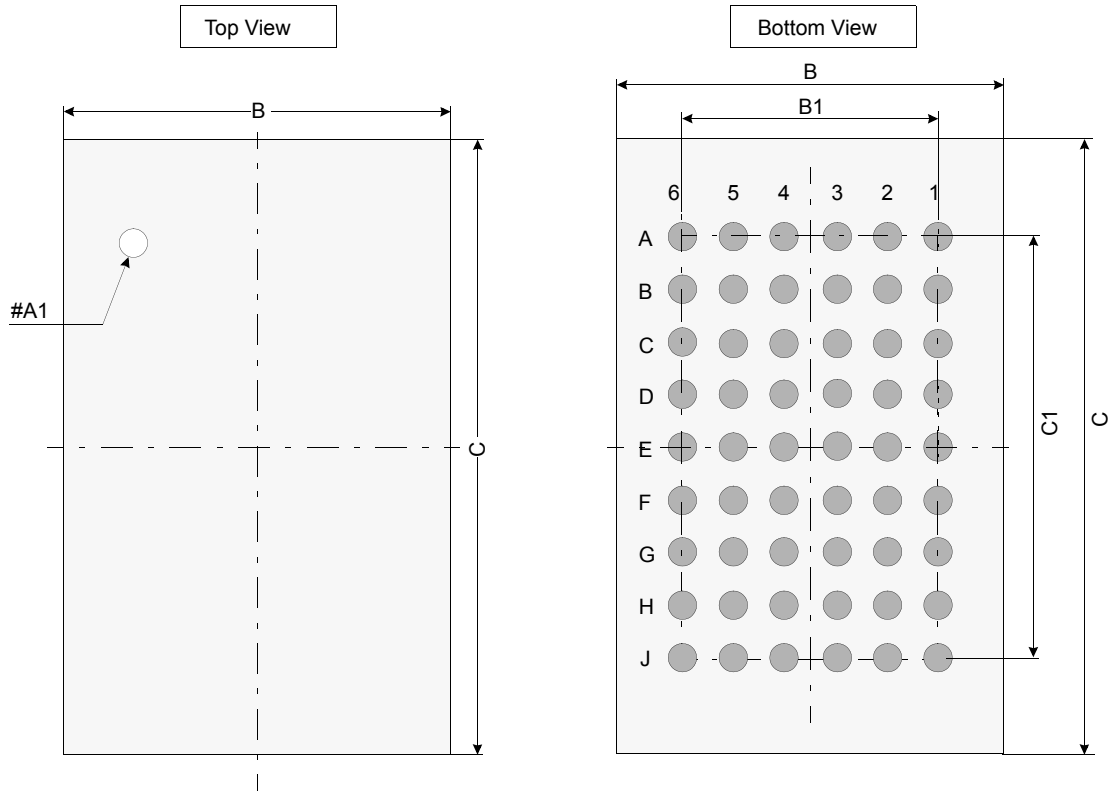


1. Refresh can not be implemented when tBEADV is in the range of 0ns ~ 13ns. It may cause Refresh fail to use the device under that condition over 2.5us without CS toggling. To avoid Refresh fail, 13ns for all frequency is needed for tBEADV.
2. /WAIT Low(tWL) : Data not available(driven by CS low going edge or ADV low going edge)
/WAIT High(tWH) : Data available(driven by Latency-1 clock)
/WAIT High-Z(tWZ) : Data don't care(driven by CS high going edge)
3. Multiple clock risings are allowed during low ADV period. The data starts after set Latency from the last clock rising.
4. Burst operation should not be longer than (tBC)2.5μs.

PACKAGE DIMENSION

54 BALL FINE PITCH BGA(0.75mm ball pitch)

Unit: millimeters



| | Min | Typ | Max |
|----|------|------|------|
| A | - | 0.75 | - |
| B | 5.90 | 6.00 | 6.10 |
| B1 | - | 3.75 | - |
| C | 7.90 | 8.00 | 8.10 |
| C1 | - | 6.00 | - |
| D | 0.40 | 0.45 | 0.50 |
| E | - | - | 1.00 |
| E1 | 0.25 | - | - |
| Y | - | - | 0.10 |

Notes.

1. Ball counts: 54(9 row x 6 column)
2. Ball pitch: (x,y)=(0.75 x 0.75)(typ.)
3. All tolerance are ± 0.050 unless specified beside figure.
4. Typ: Typical
5. Y is coplanarity